



# *DC and RF reliability of Advanced CMOS technologies... ...and something else*



Electron Devices Society



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**This is an eruptive talk that has to do with energy, reliability, monitoring, and prediction.**



## An example: self-driving cars(SDC)



- Sensors
- Communications
- Electronics
- Mechanics
- Software



Is the SDC reliable enough?

Which are the less reliable components?

## The three-modules SDC

Computer system

1 Perception module

Cameras, radar, LIDAR

Model of the world,  
and machine-learning  
systems that identify  
objects

2 Prediction module

Forecasts the world

Change of lane?,  
object crossing the  
road?, will or not a  
pedestrian will cross  
the road?

3 Response module

Address an action to  
the vehicle

Communication and transduction

Slow down, speed up,  
total stop, detour,  
park, go ahead, turn  
off, etc

5G will do it!

Lower end

0.6 GHz

3.1-3.55 GHz

3.7-4.2 GHz

Higher end

27.5-28.3 GHz

37-40 GHz

test

64-71 GHz

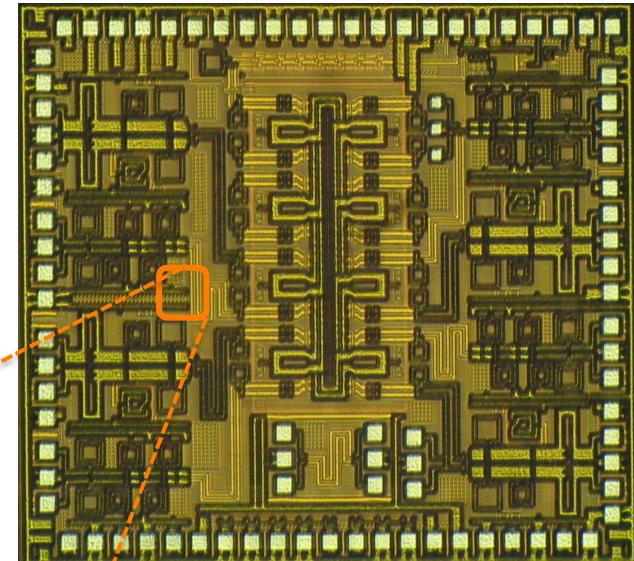
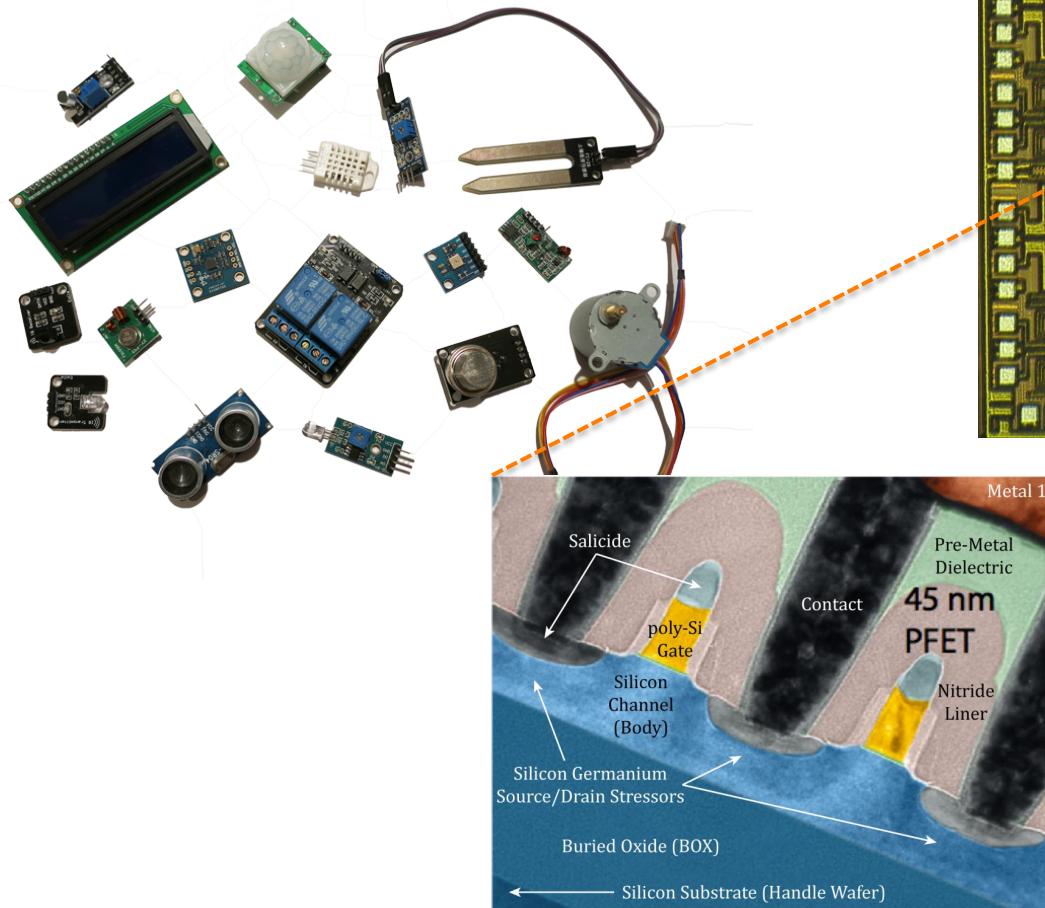
Same as human-like reflexes velocity!

- IoT, virtual reality, artificial intelligence, a mobile phone connected to a SDC will get you the power of a supercomputer on the go!
- Speed and data processing will provide the SDC the timing of human reflexes with the equivalent of two-million gigabits!
- 5G electronics, data processing, and communications will become a SDC into a supercomputer on-wheels, and more...

# Lets focus on electron devices reliability

Solid-state electronic chip

Sensors of different kind



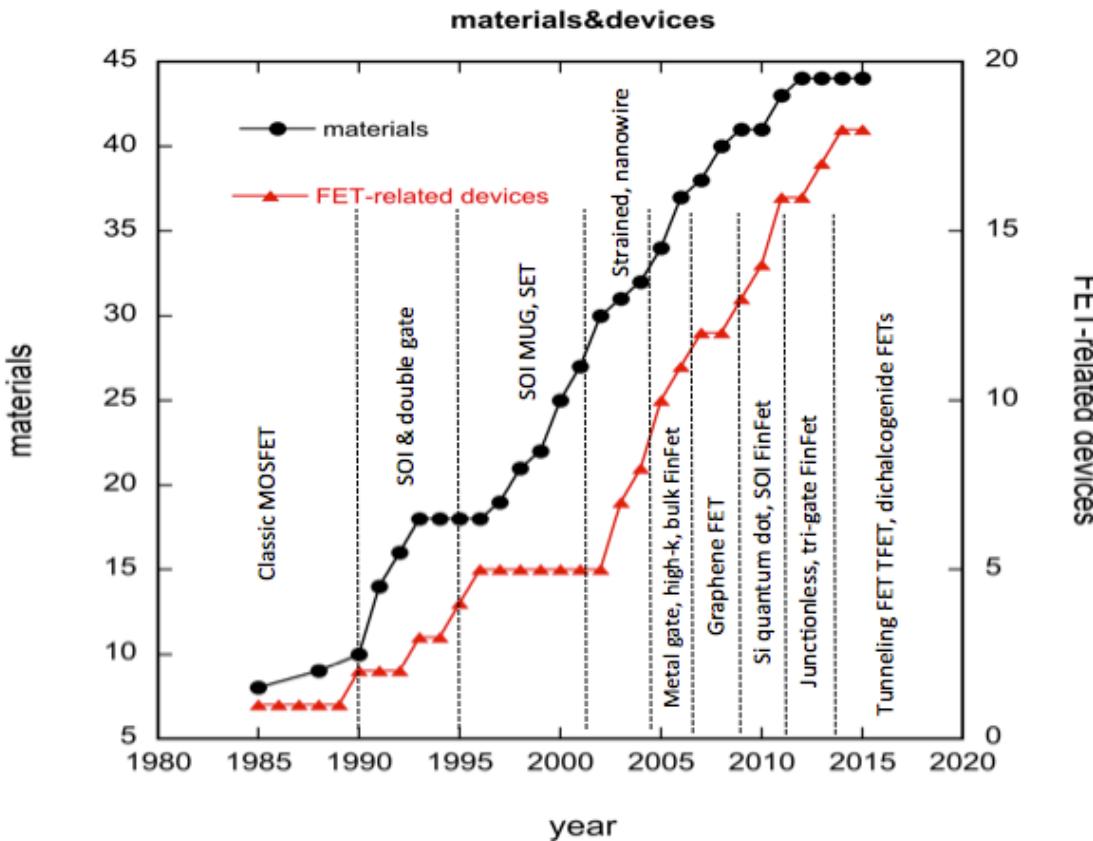
Software, communications?

# Ethics!



## [ Lets open a technical breviary here ]

Today more the 50 different elements, of the periodic table, are used in the fabrication of FET devices.



Edmundo A. Gutiérrez-D.,  
 "Nano-Scaled Semiconductor Devices, Physics, Modelling,  
 Characterisation, and Societal Impact", IET Press, 2016.

Why is this a  
relevant fact?



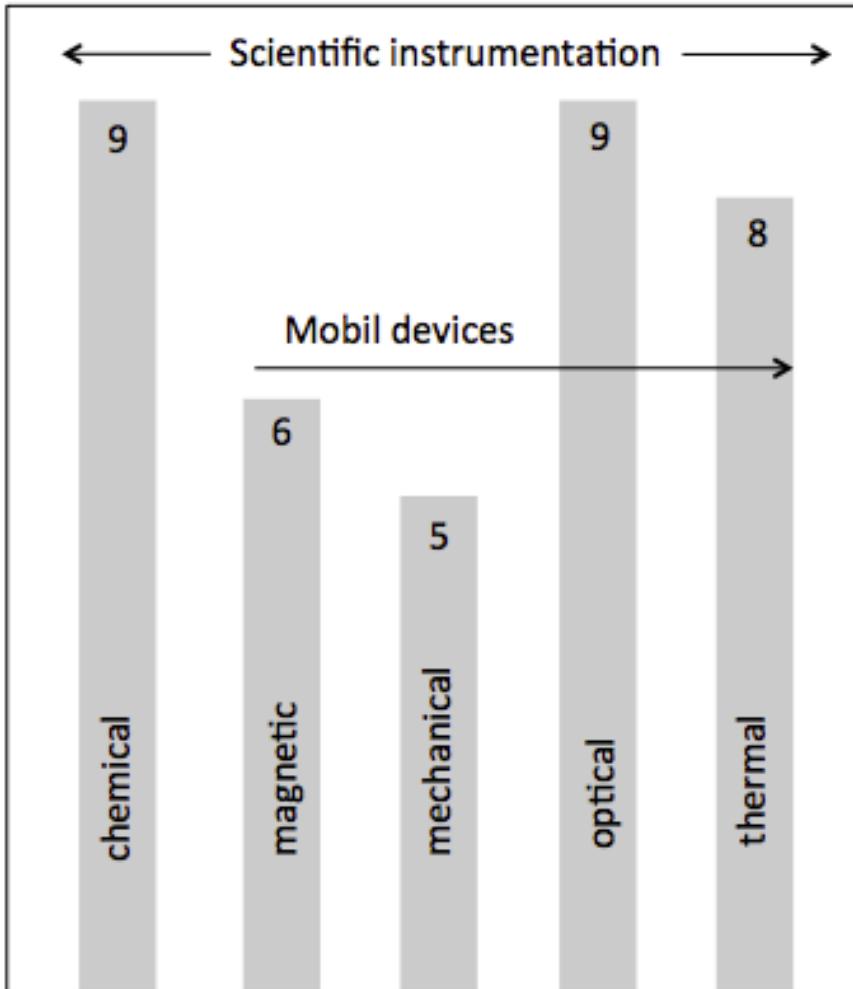
## There are two ways to explore!

Bio-chemical,  
neurology, gas,  
e-nose, cancer  
detection, ...

Pressure, fluids,  
Security,  
hearing-aid,...

Magnetic,  
DNA, NMR,...

Temperature,  
IR, imaging,  
medicine,  
flow,...



Edmundo A. Gutiérrez-D.,  
 "Nano-Scaled Semiconductor Devices, Physics, Modelling,  
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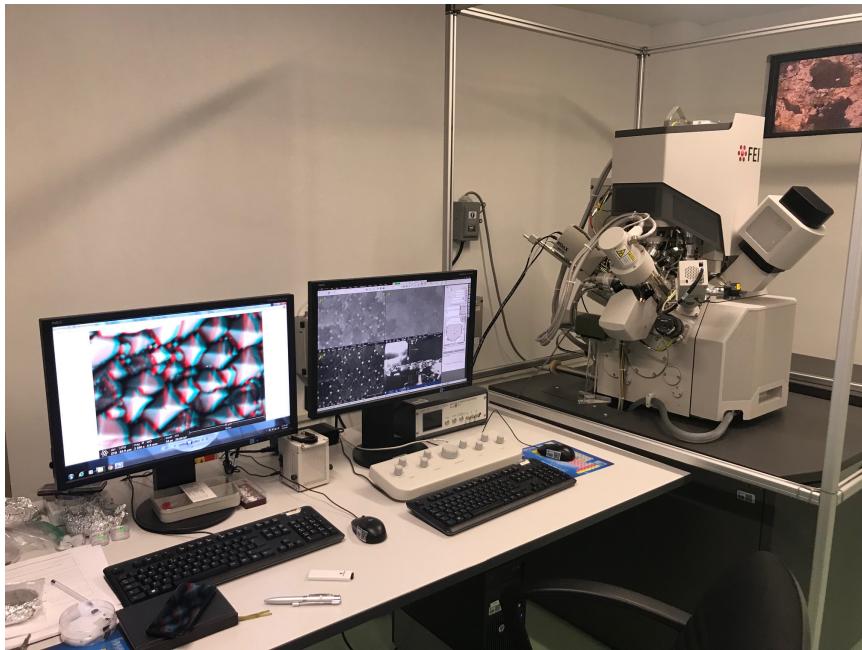
- 1.- Develop CMOS-compatible sensors, or**
- 2.- Use built-in based sensors to monitor reliability, and study sensor reliability.**

Devices & circuits



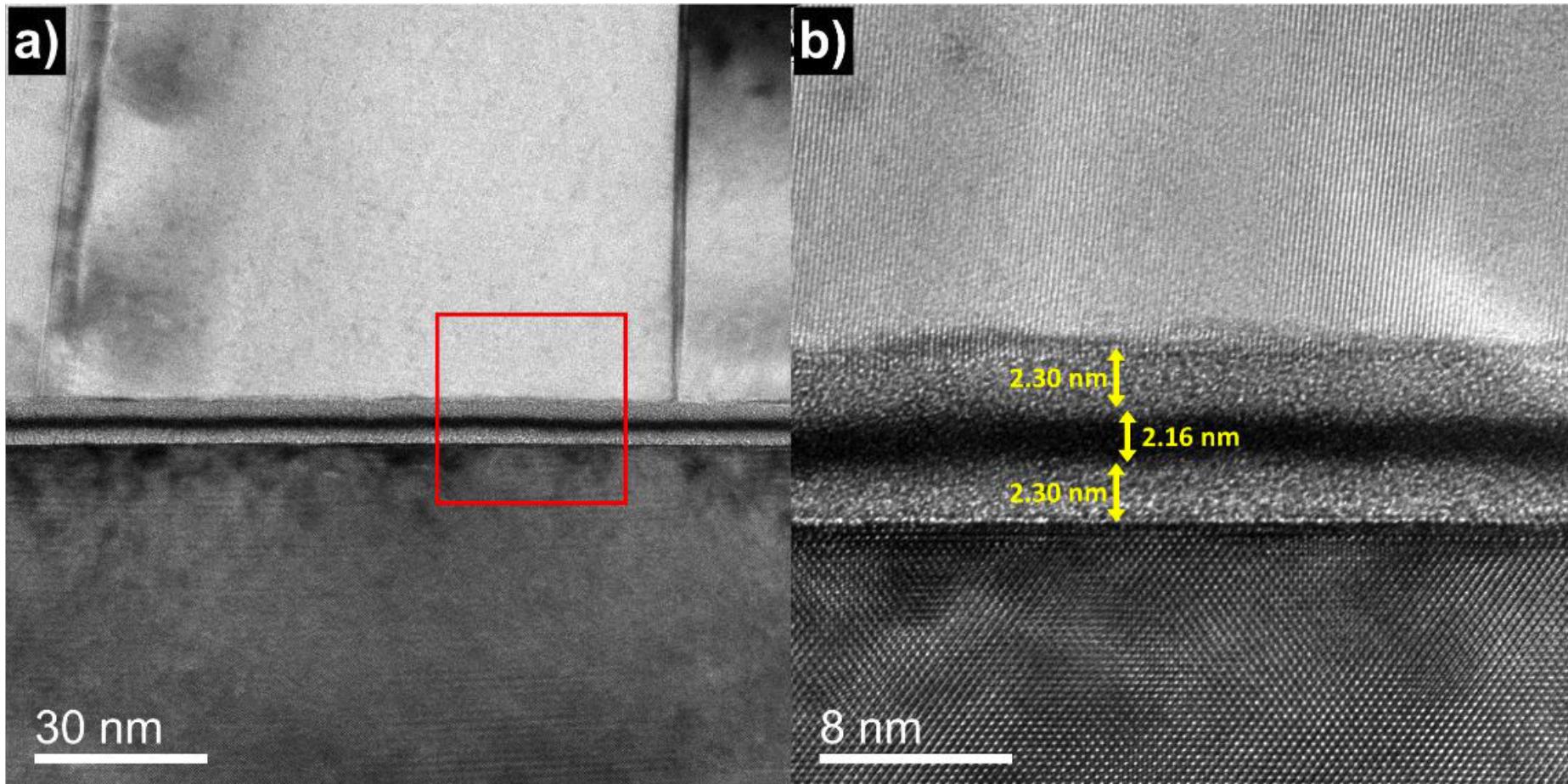
## Lets go back, and go deeper into the nano-scale interfaces

### INAOE electron microscopy laboratory



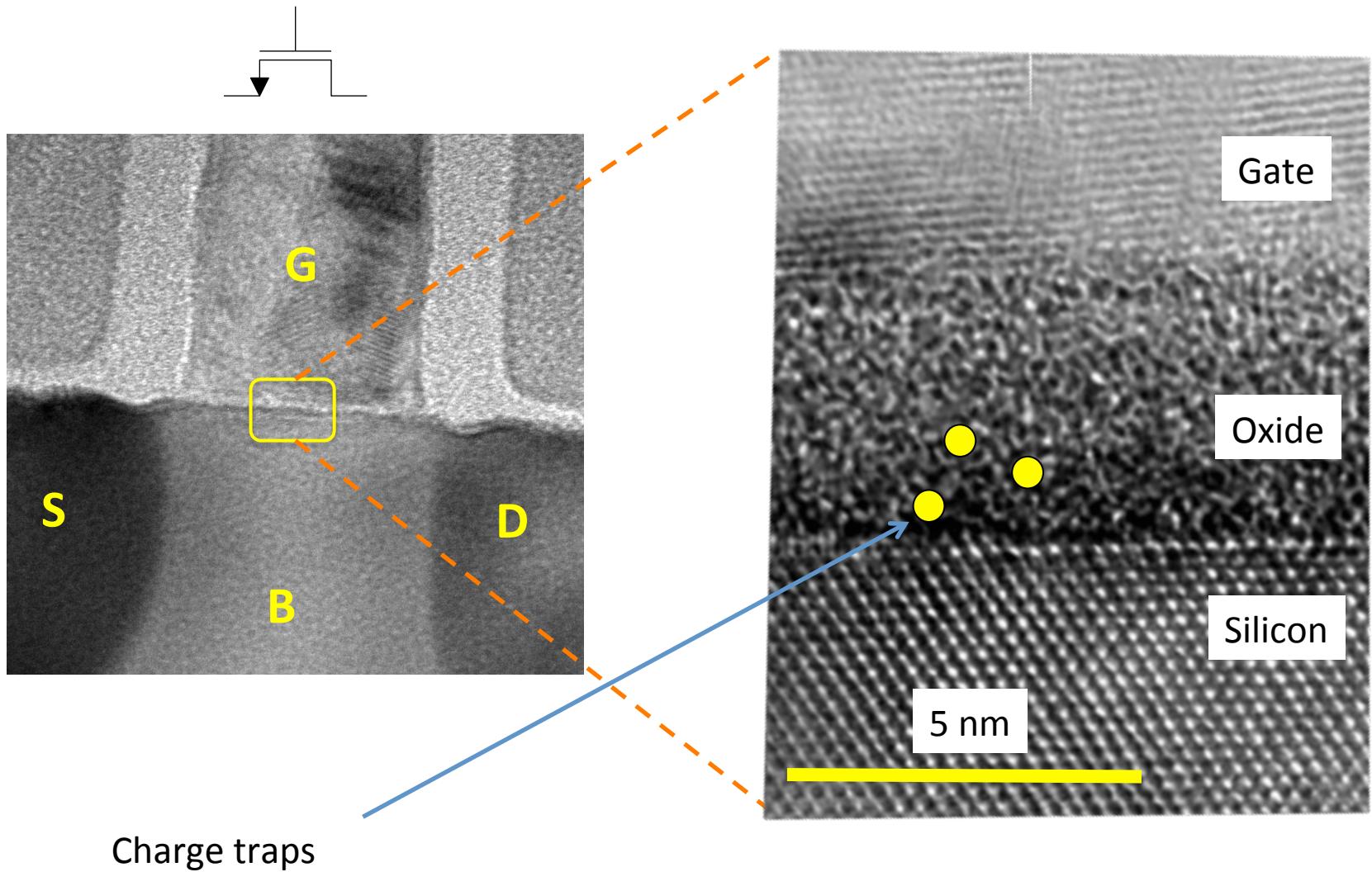
INAOE has the fabrication and characterization capability to study atomic-scale interfaces, and its interaction with external physical variables: light, temperature, magnetic field, etc.

...and see what is going on in the interfaces

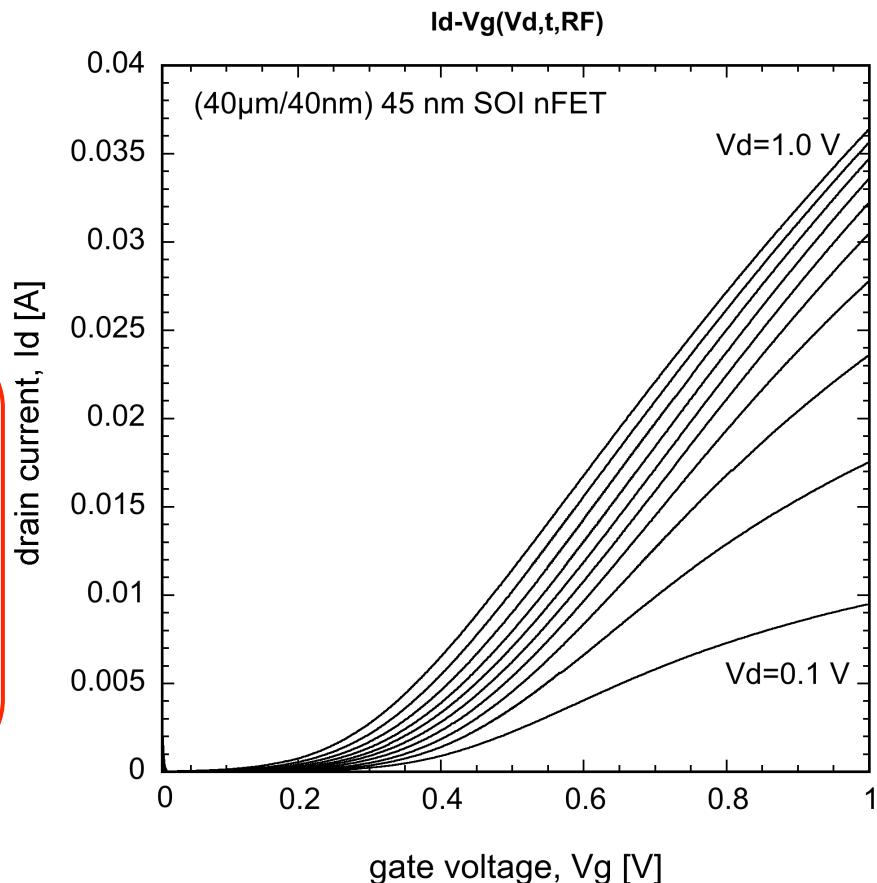
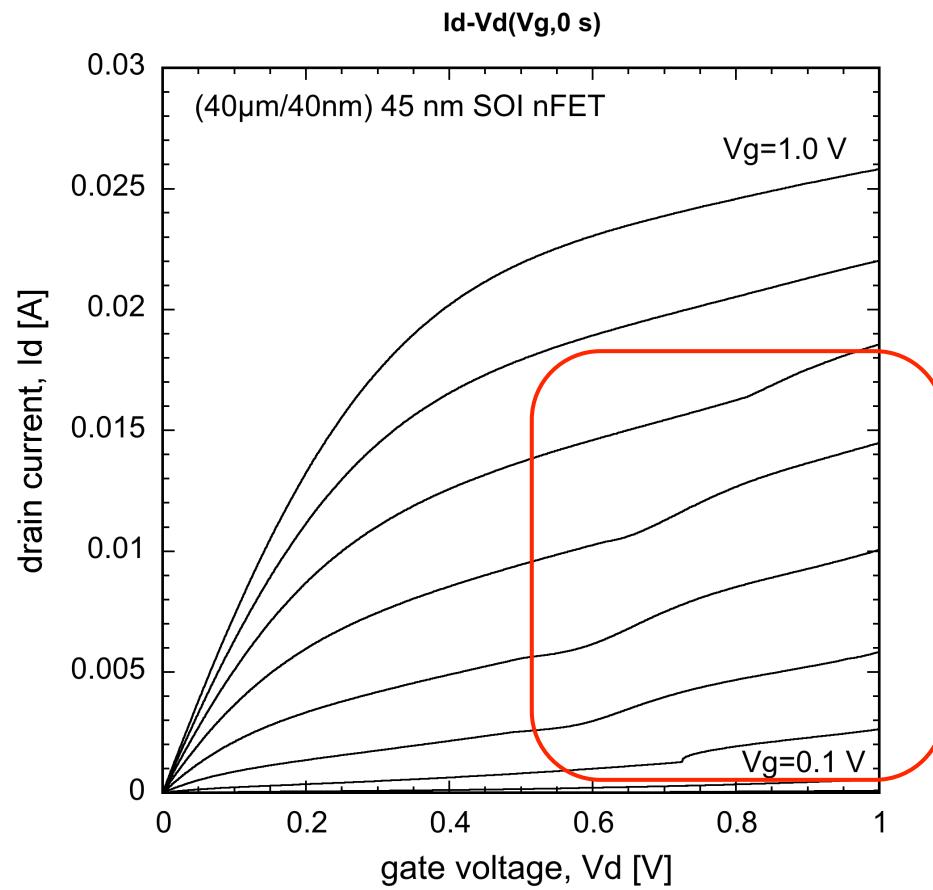


# The FET semiconductor-oxide interface

FET: Field Effect Transistor



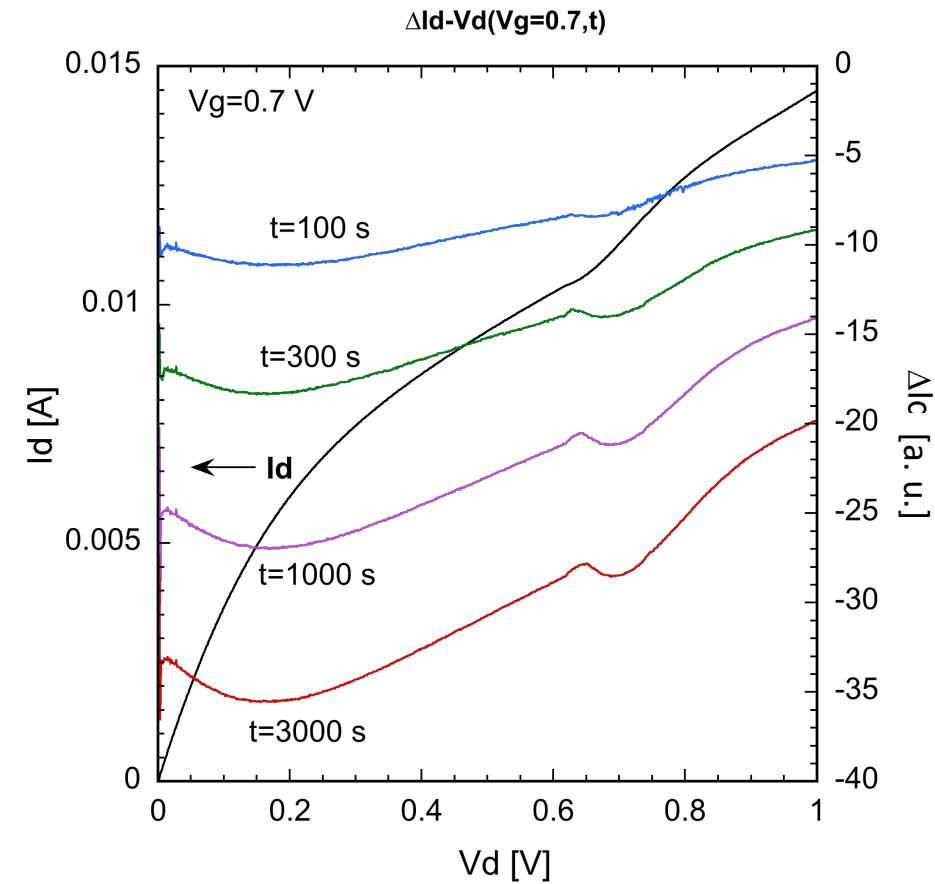
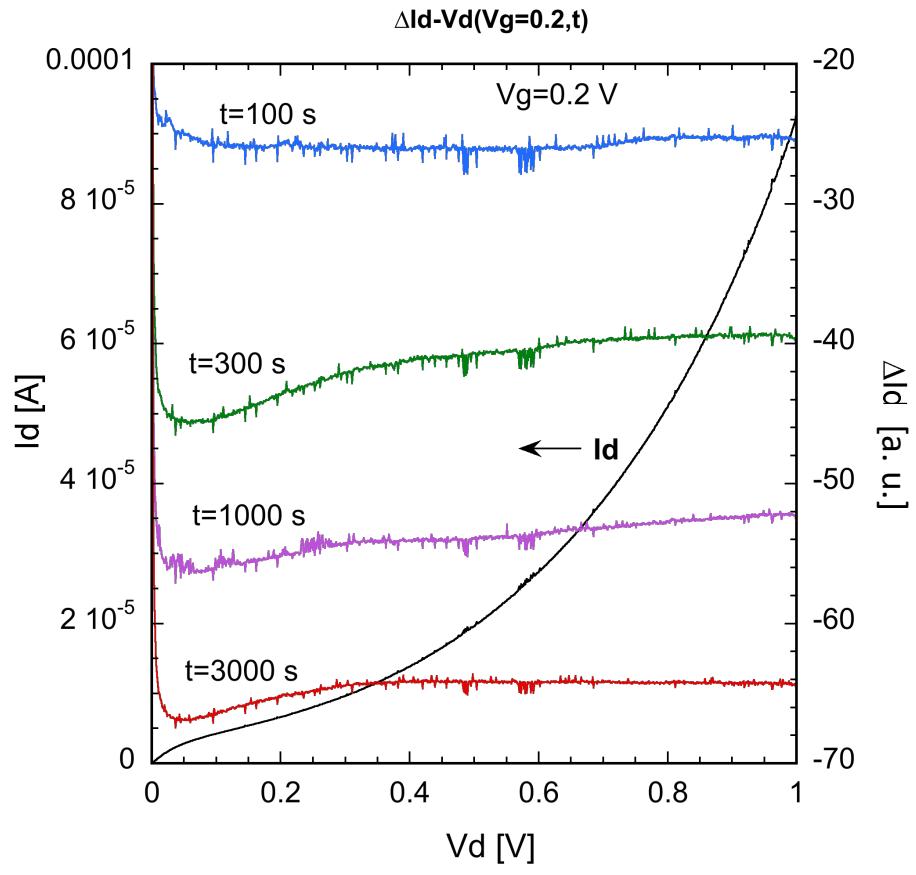
# The fresh I-V characteristics of a 45 nm SOI RF device



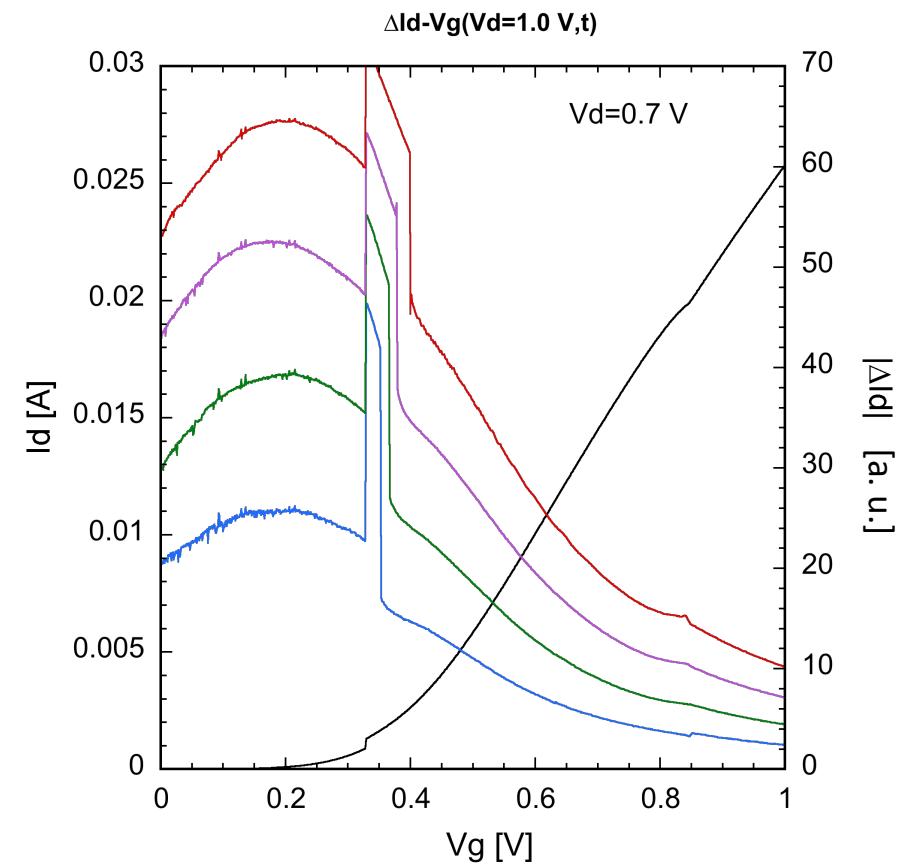
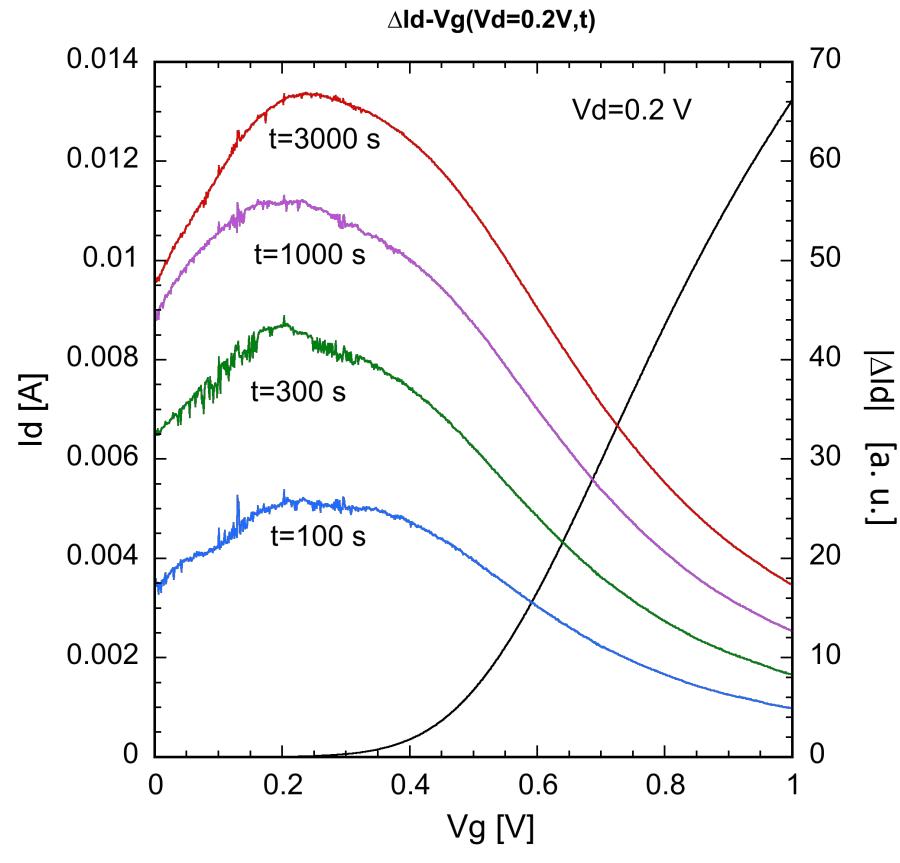
Hot-carriers (**HC**), Impact Ionization (**II**), and Self-heating (**SH**) ->degradation: reliability!

# The Id-Vd degraded characteristics

Stress over-bias conditions:  $V_d = 1.6 \text{ V}$ ,  $V_g = 0.8 \text{ V}$

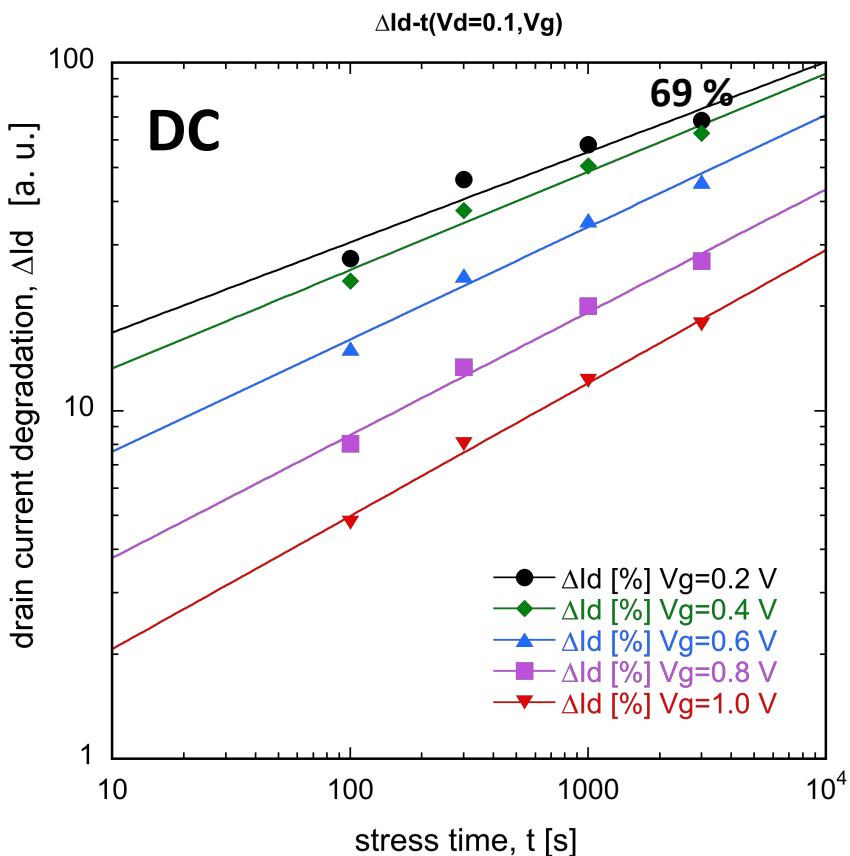


## The Id-Vg degraded characteristics

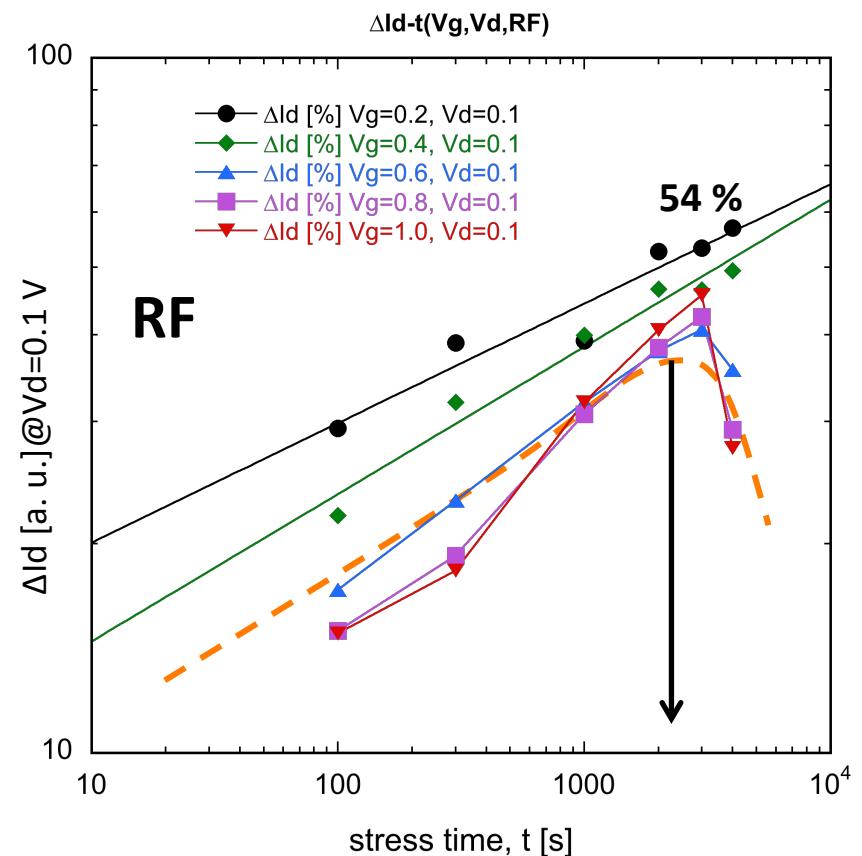


# Id degradation: time evolution under DC and RF stress

$$\Delta Id = A * t^n$$

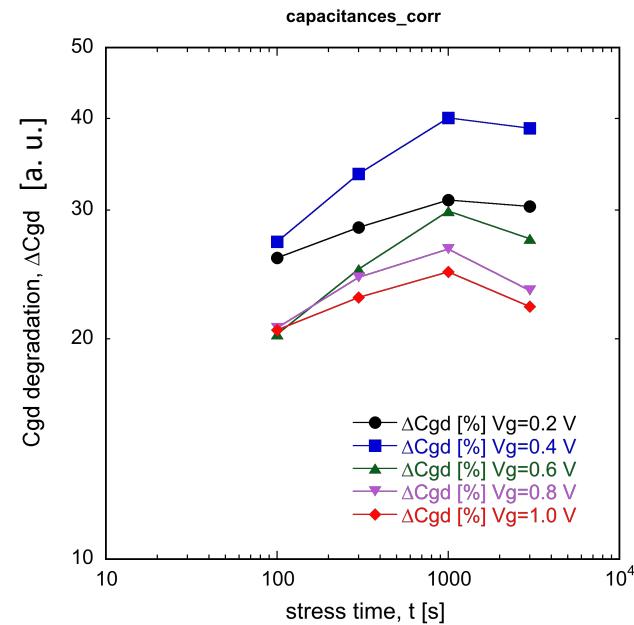
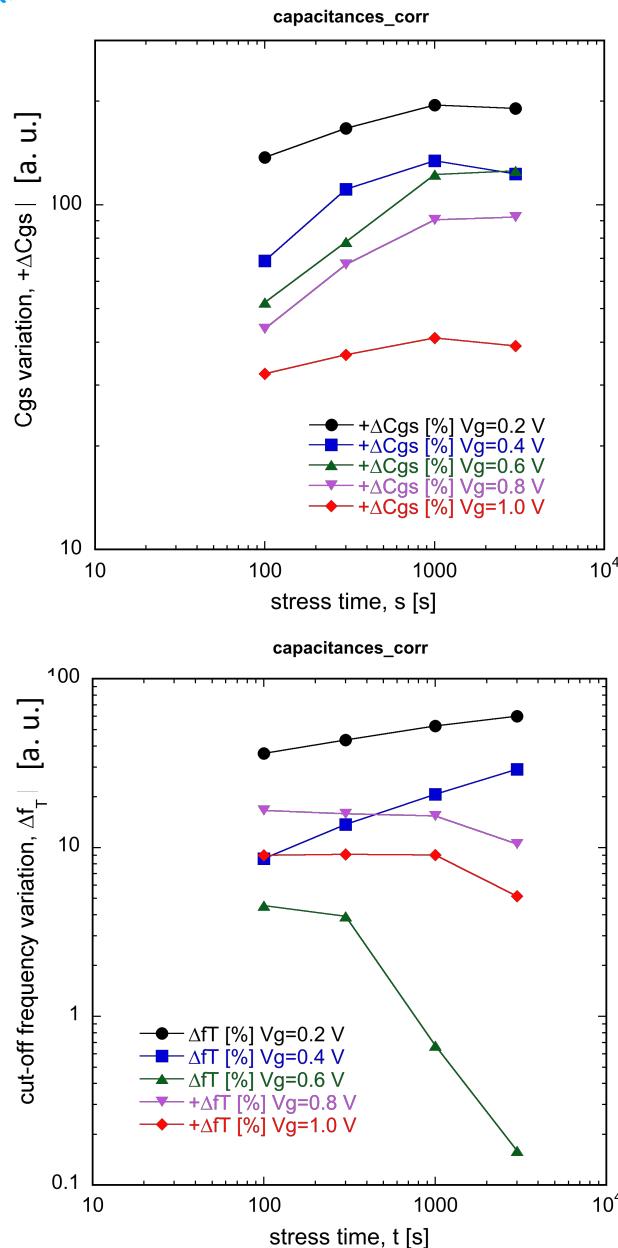


$f=28$  GHz,  $P_{in}=-20$  dBm



$\Delta Id$  roll off at  $t>1000$  s under RF stress

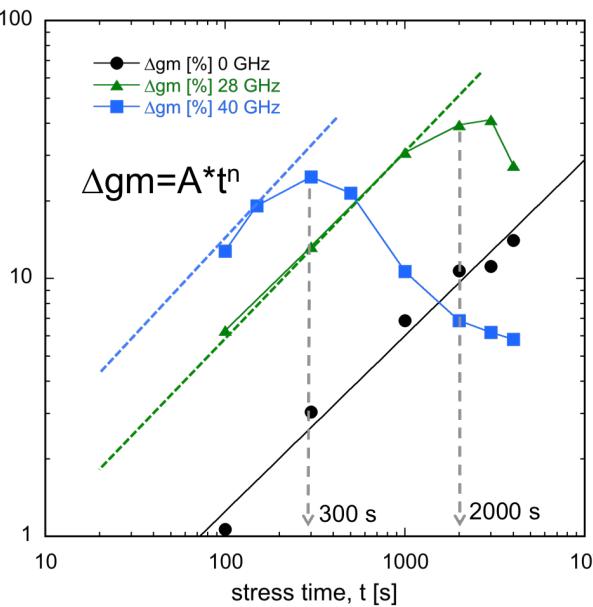
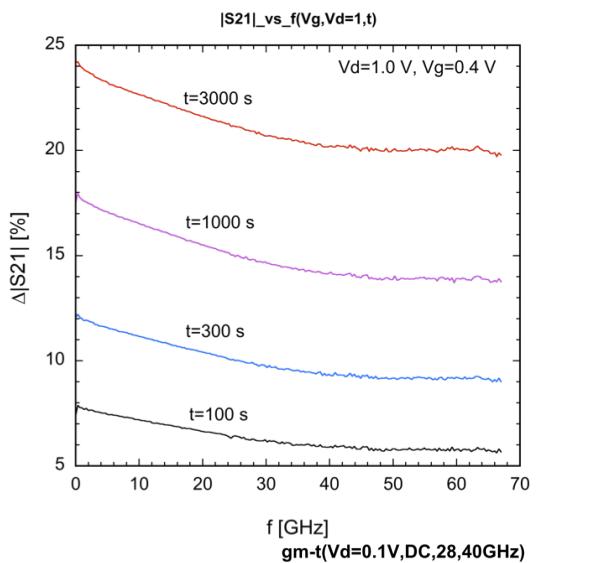
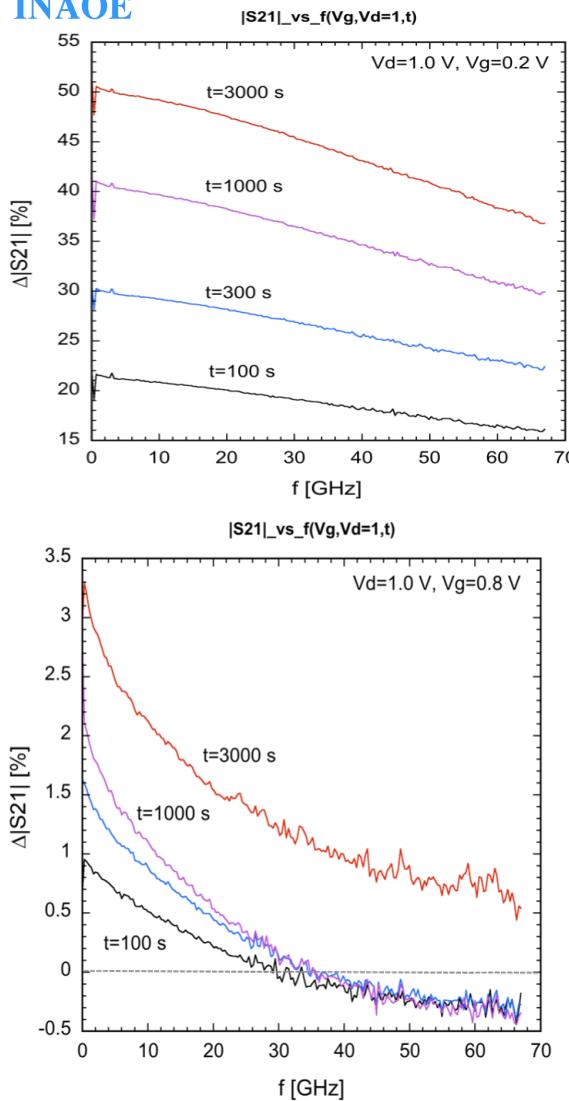
# RF parameters reliability



Opportunity:  
Big open door for scientific research

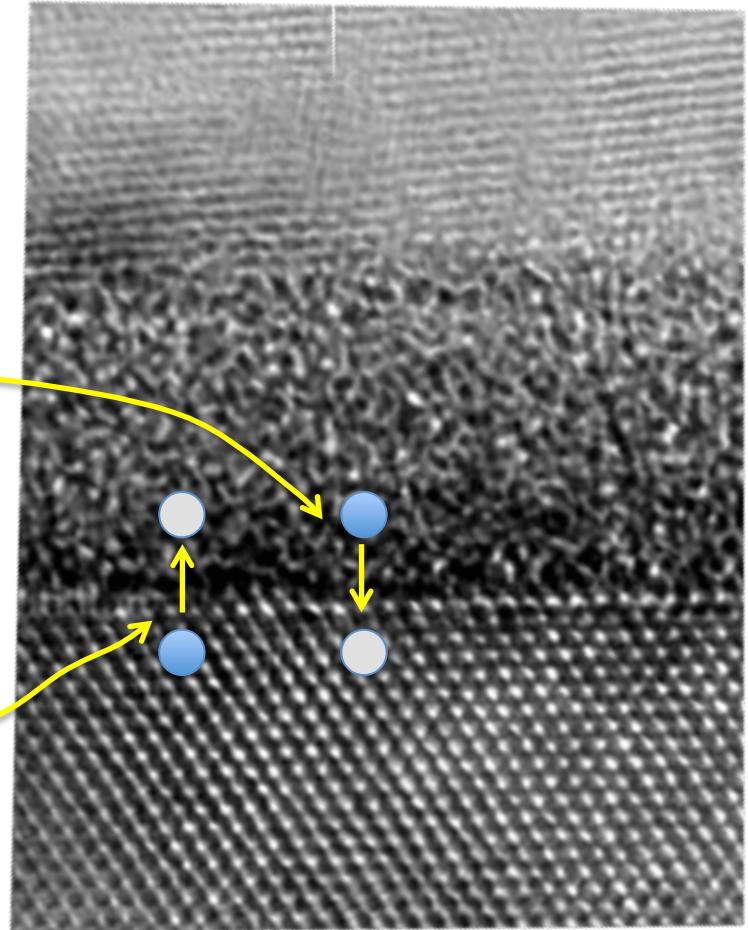
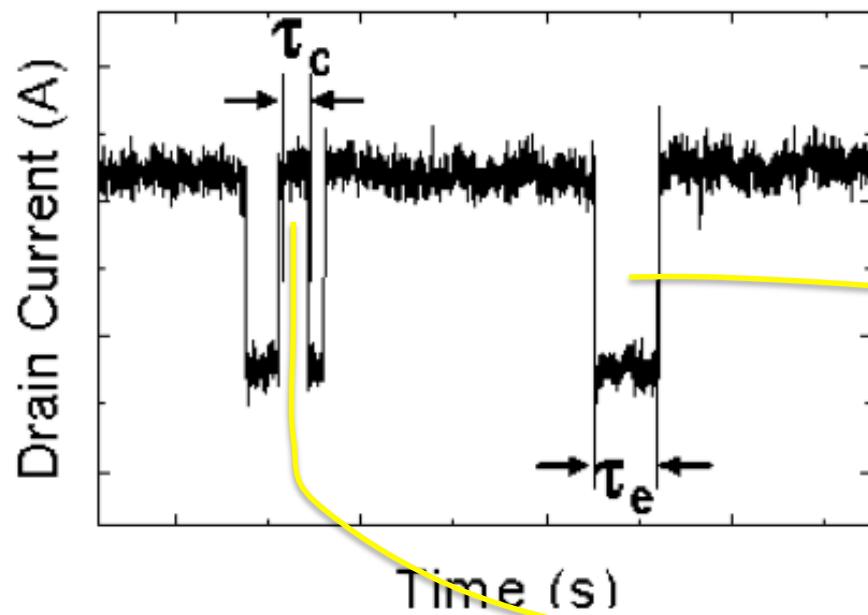


# RF S-parameters degradation 10 MHz-67 GHz

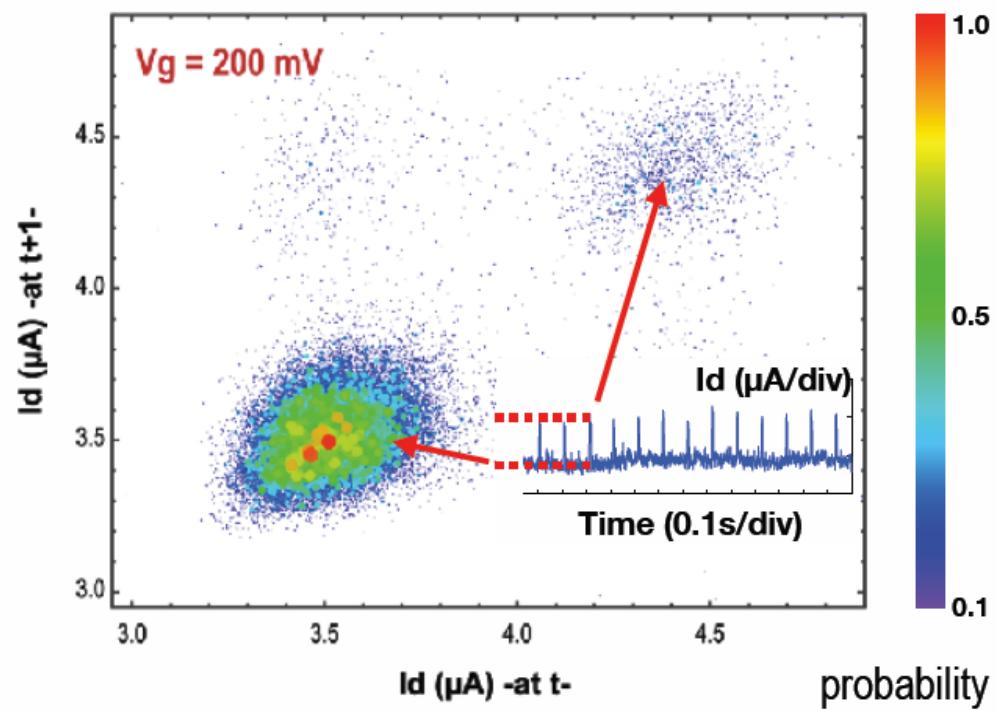
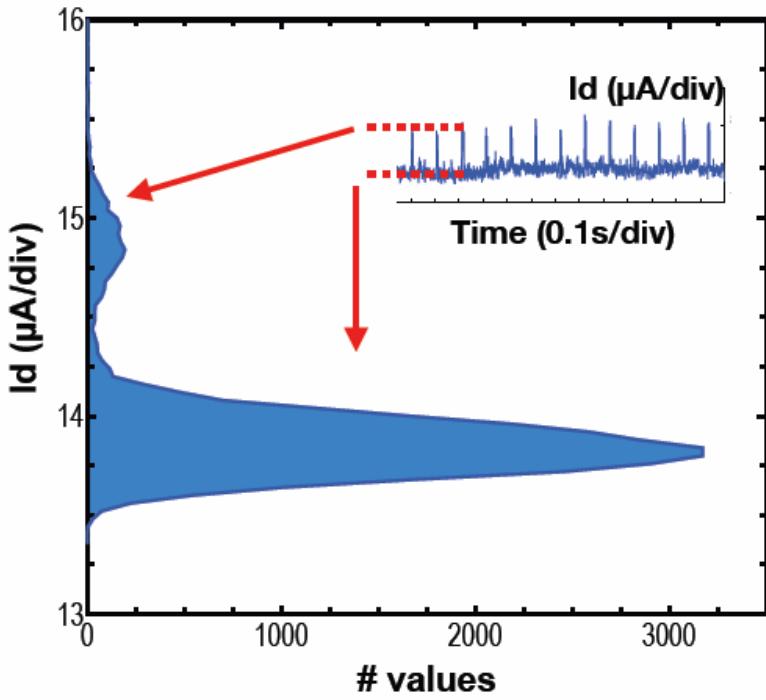
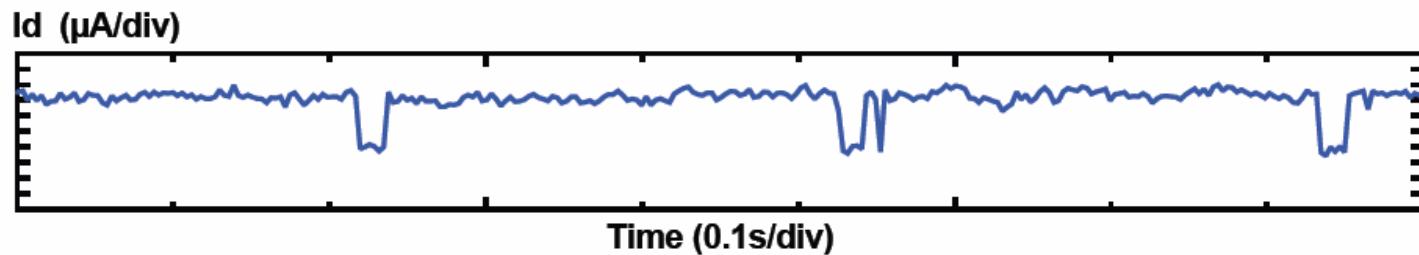


**Trap quenching,  
annihilation,  
passivation,...?**

# Capture/emission at the semiconductor-oxide interface RTN noise

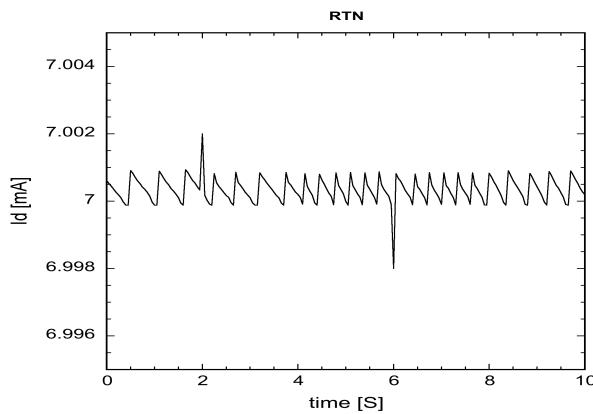
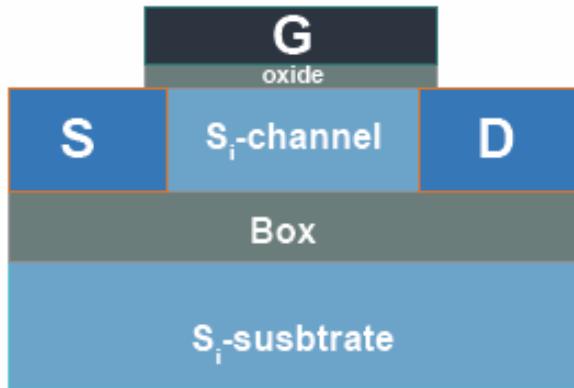


# Random Telegraph Noise RTN

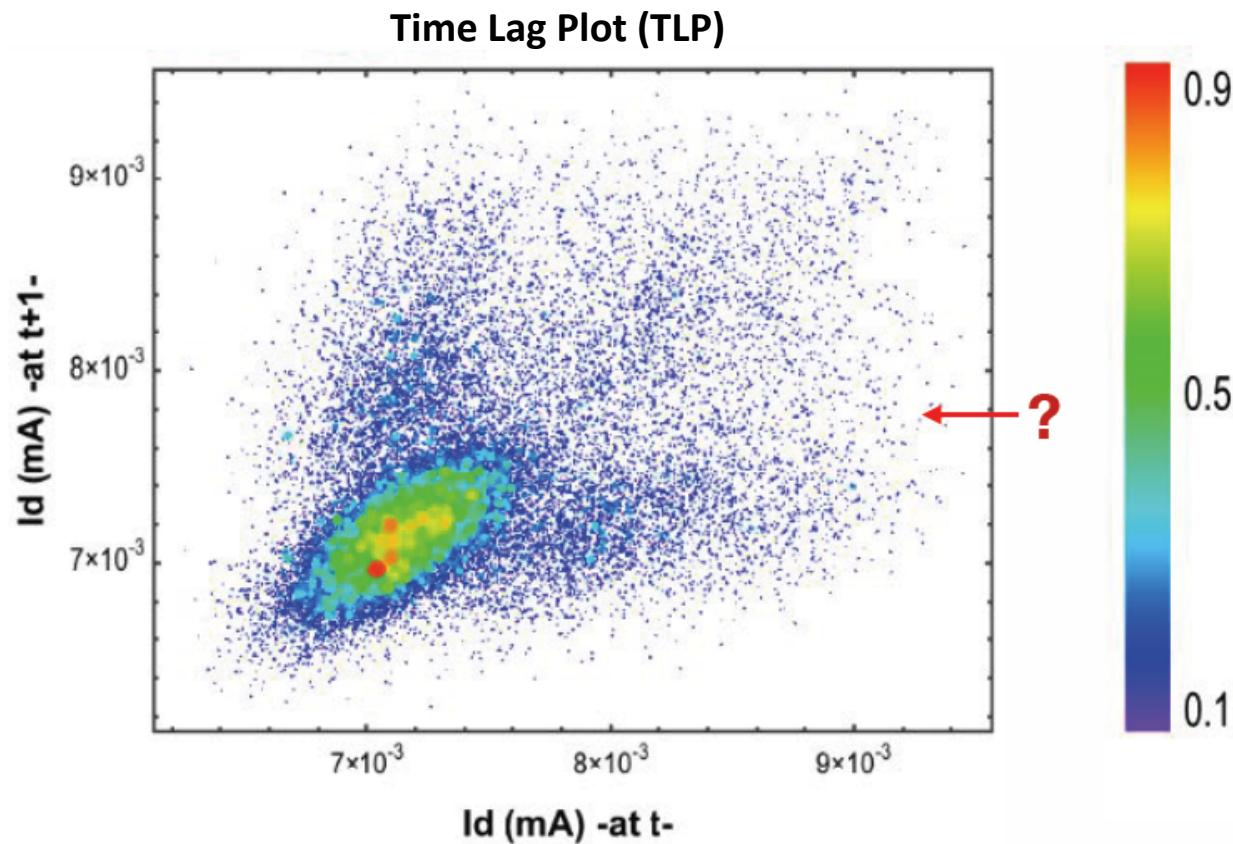


## Fresh 45 nm SOI RF device

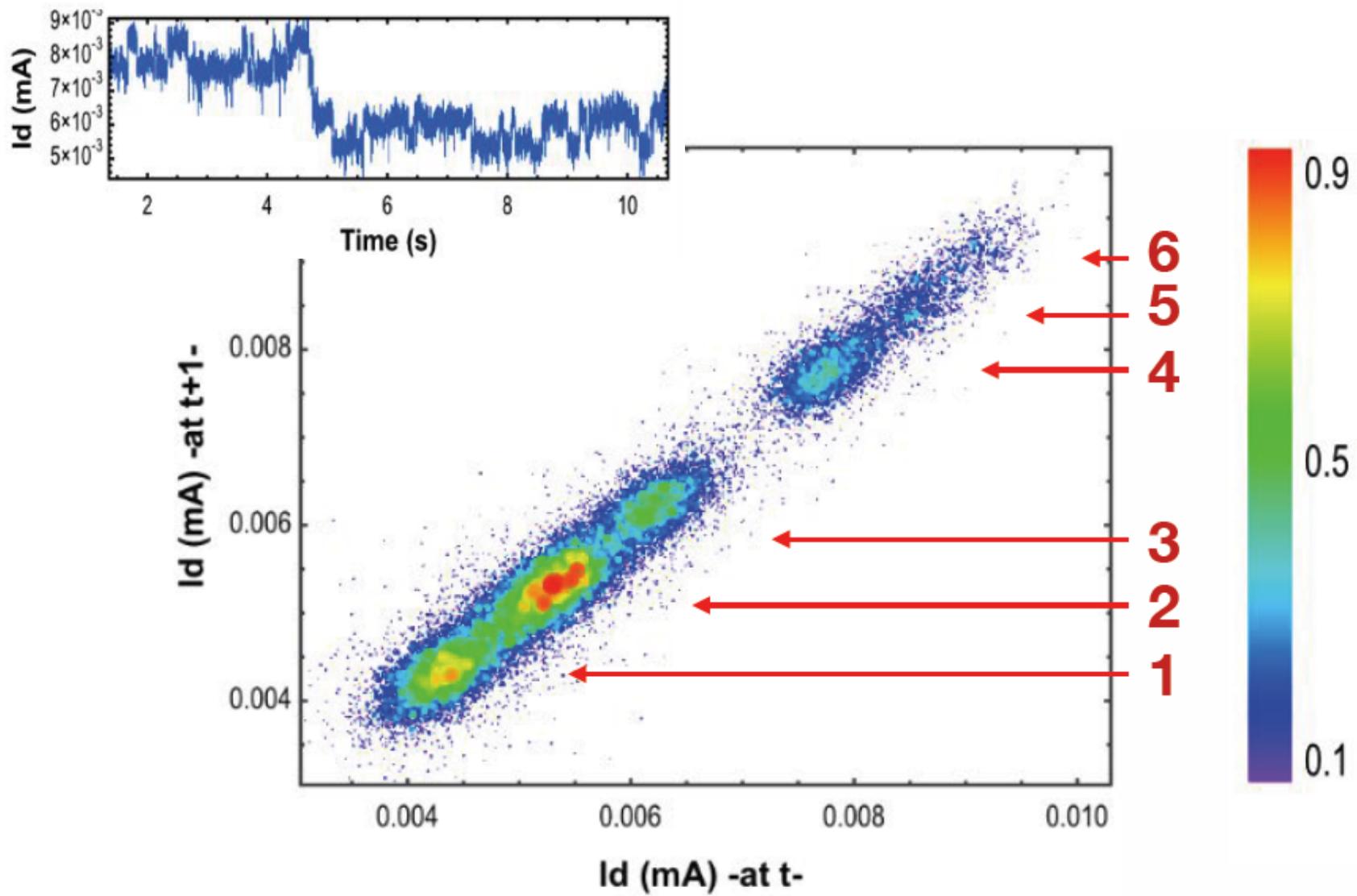
$V_d=0.1$ ,  $V_g=0.25$  V,  $t= 0$ s



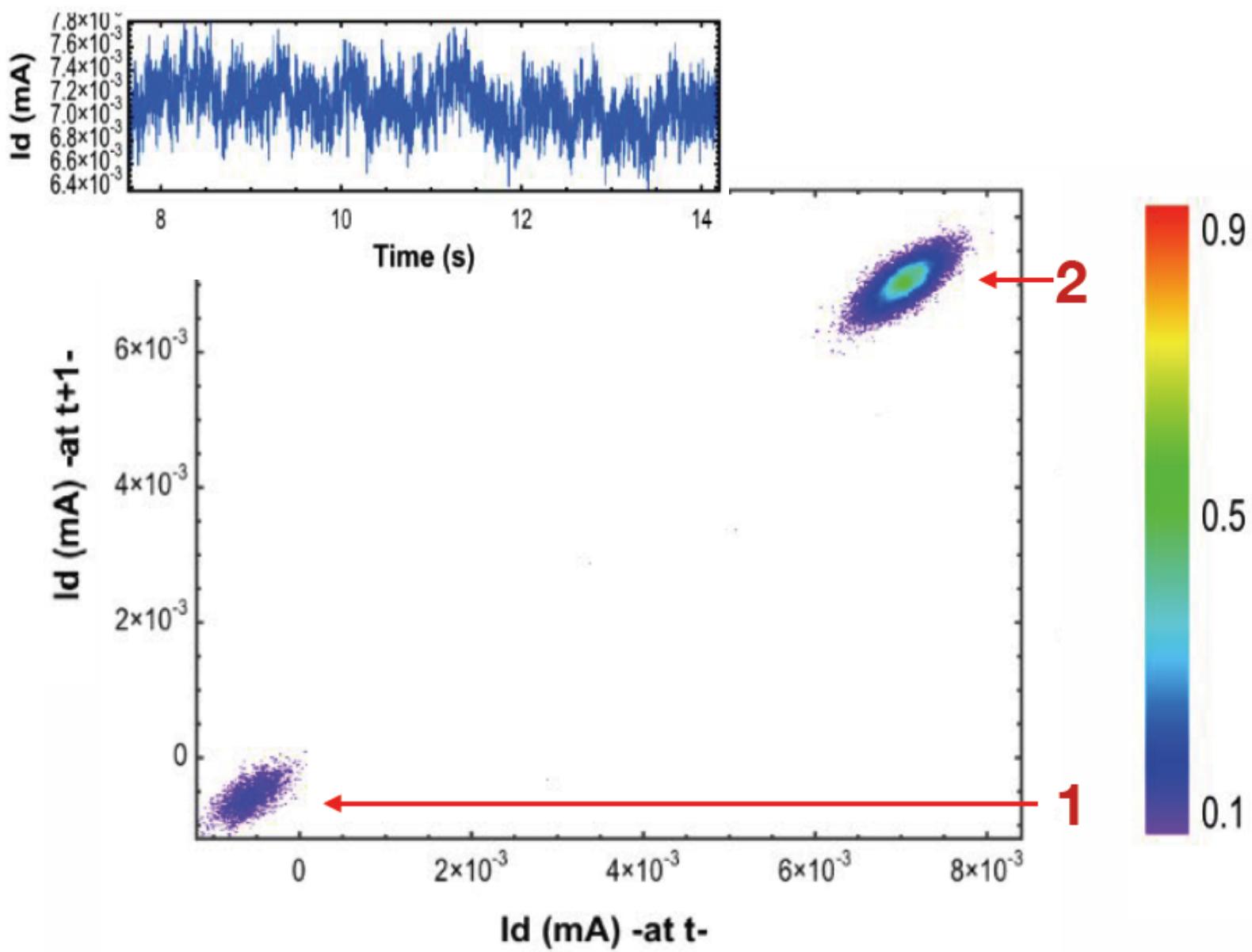
The color scale indicates the probability to find a current level in time.



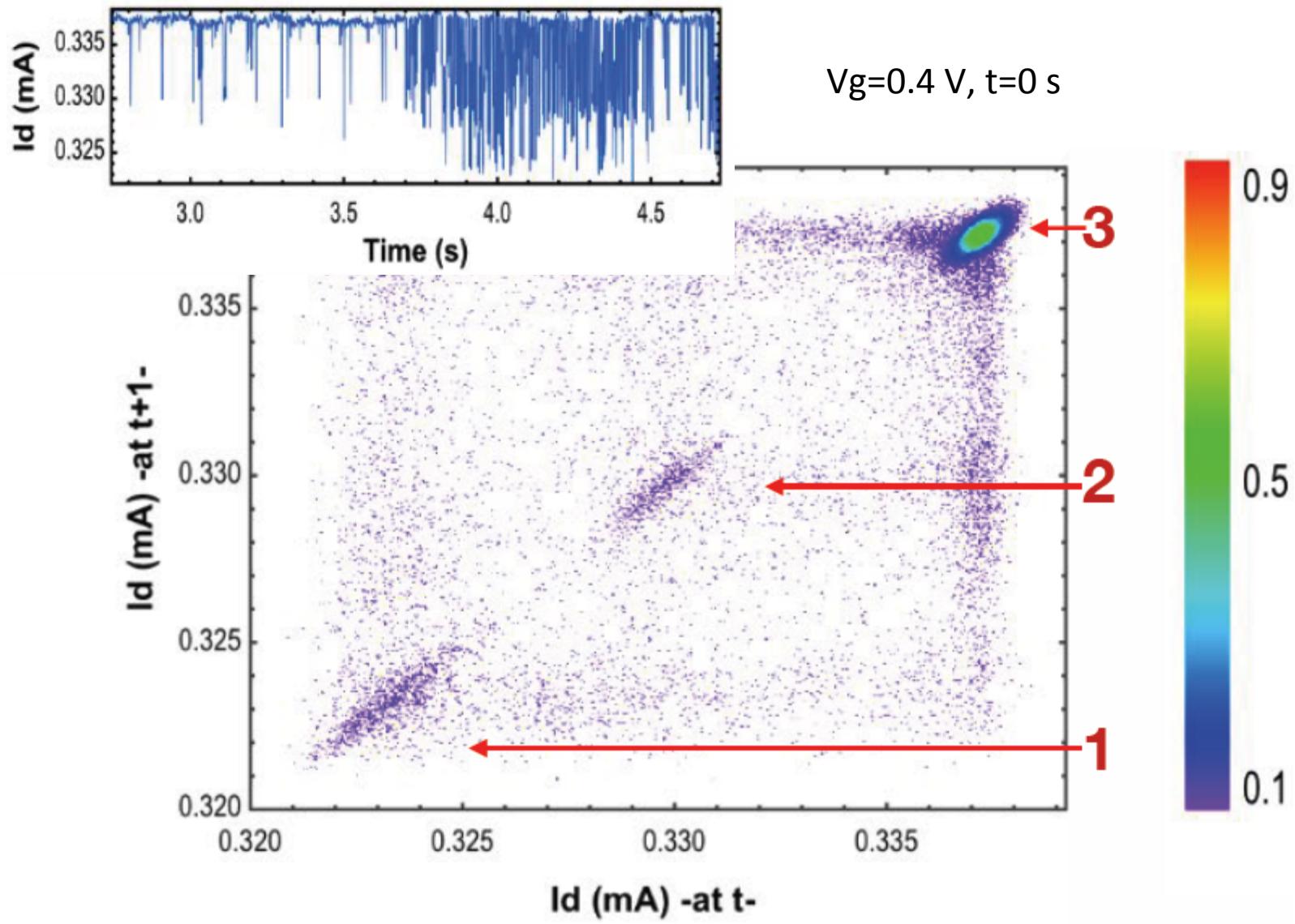
## 60 s stressed 45 nm SOI RF device



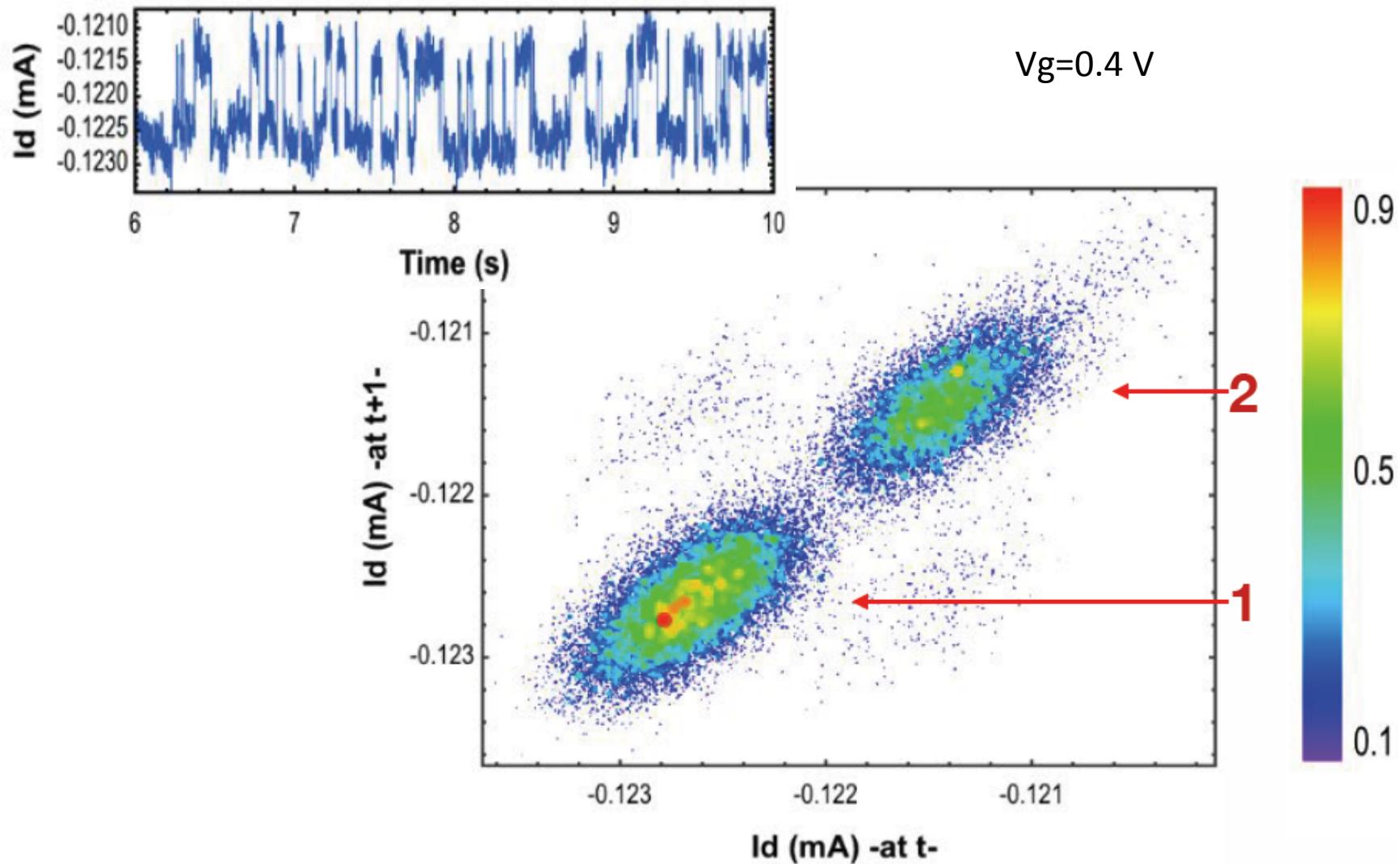
## 160 s stressed 45 nm SOI RF device



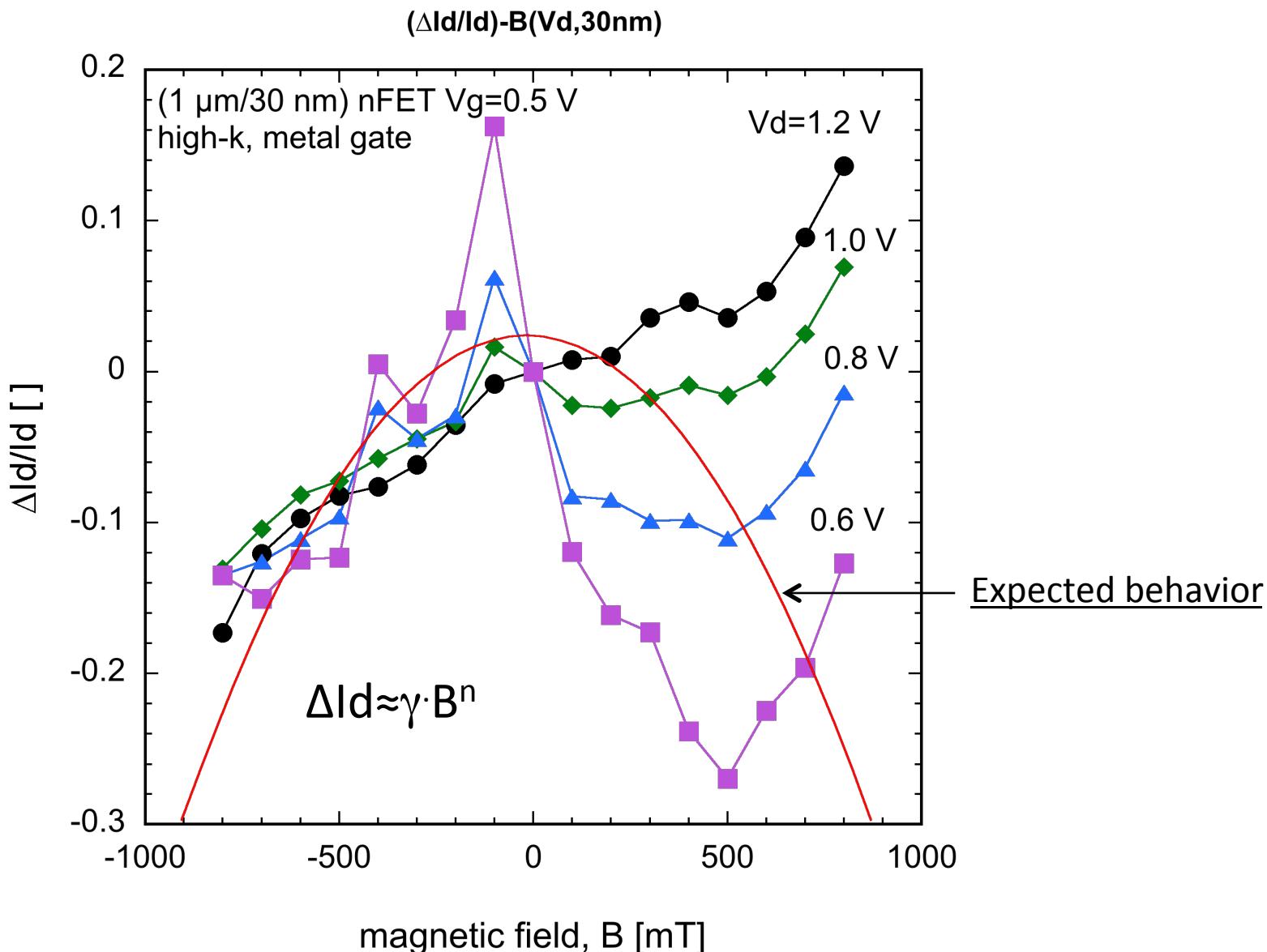
## Fresh 45 nm SOI RF device



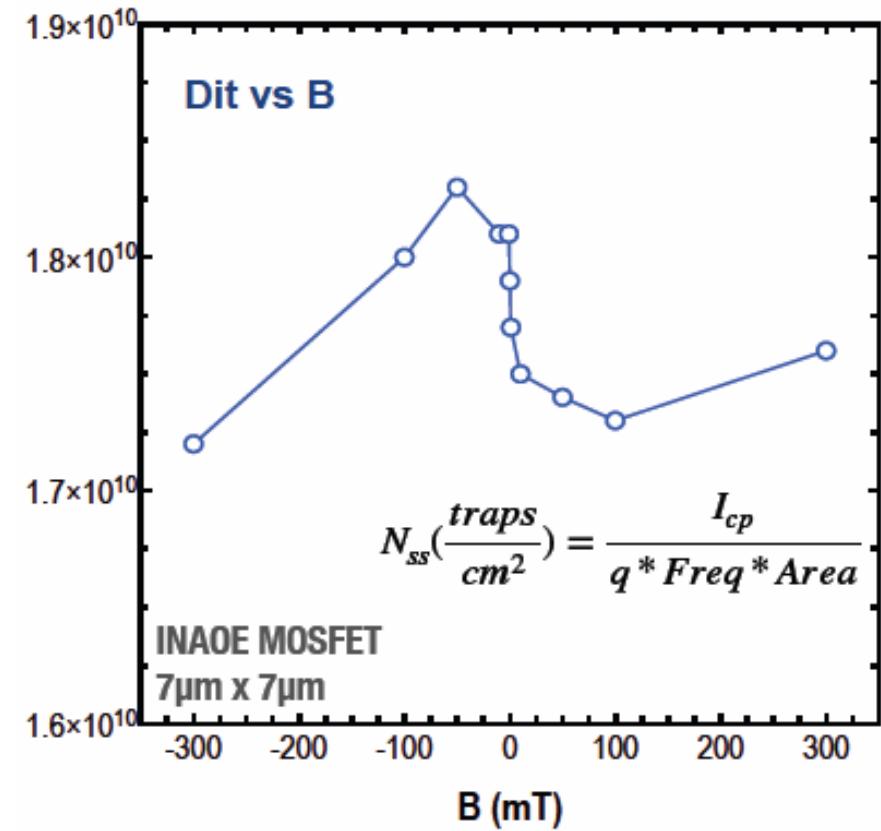
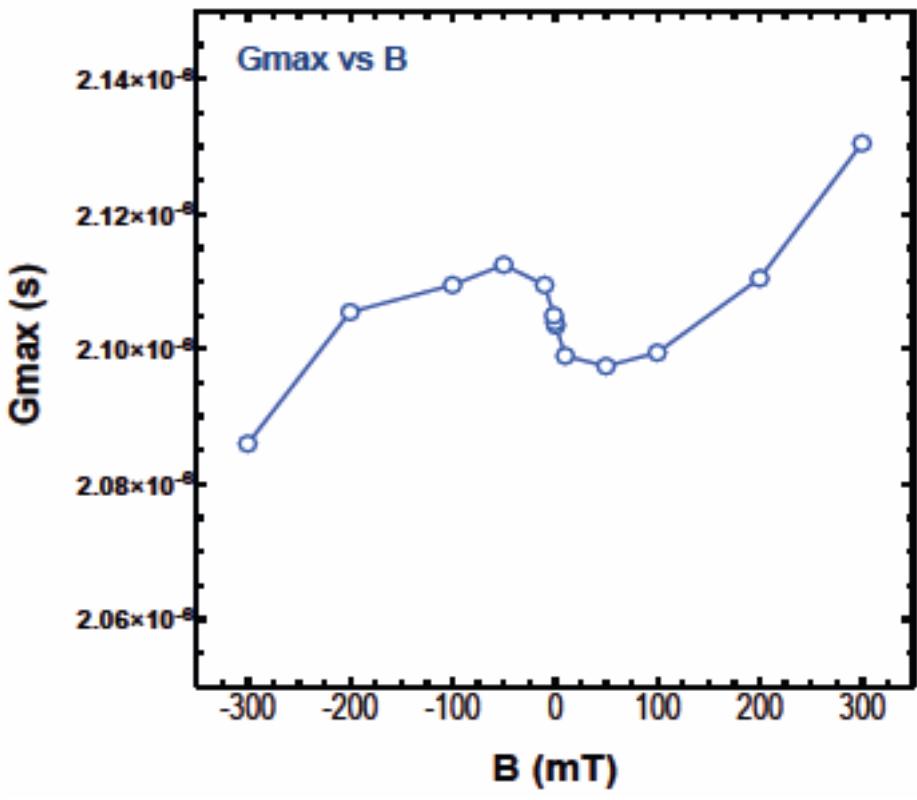
## 60 s stressed 45 nm SOI RF device



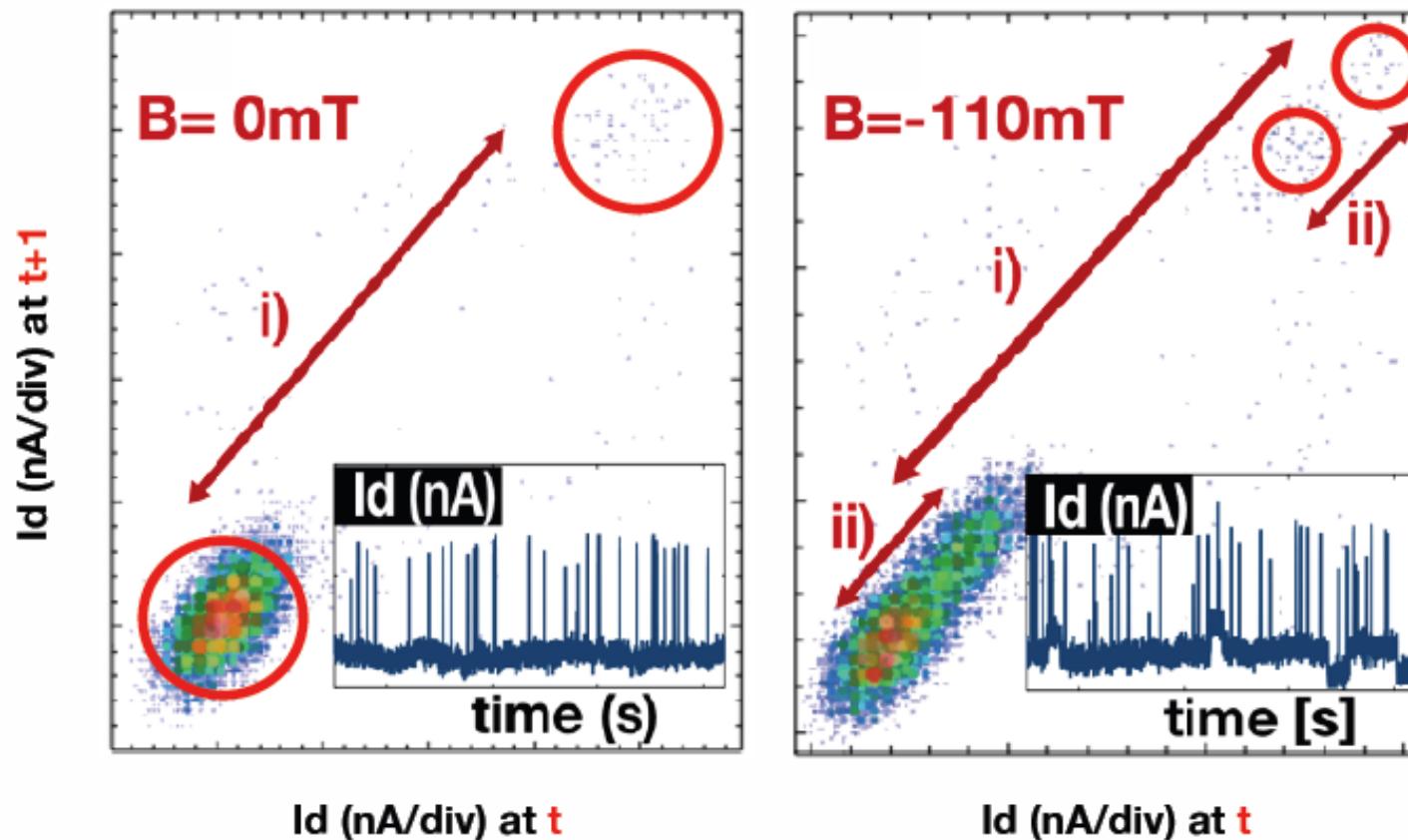
# Sensing a magnetic field with a FET device at the Si-oxide interface



# Asymmetric magneto-behavior of MOSFETs



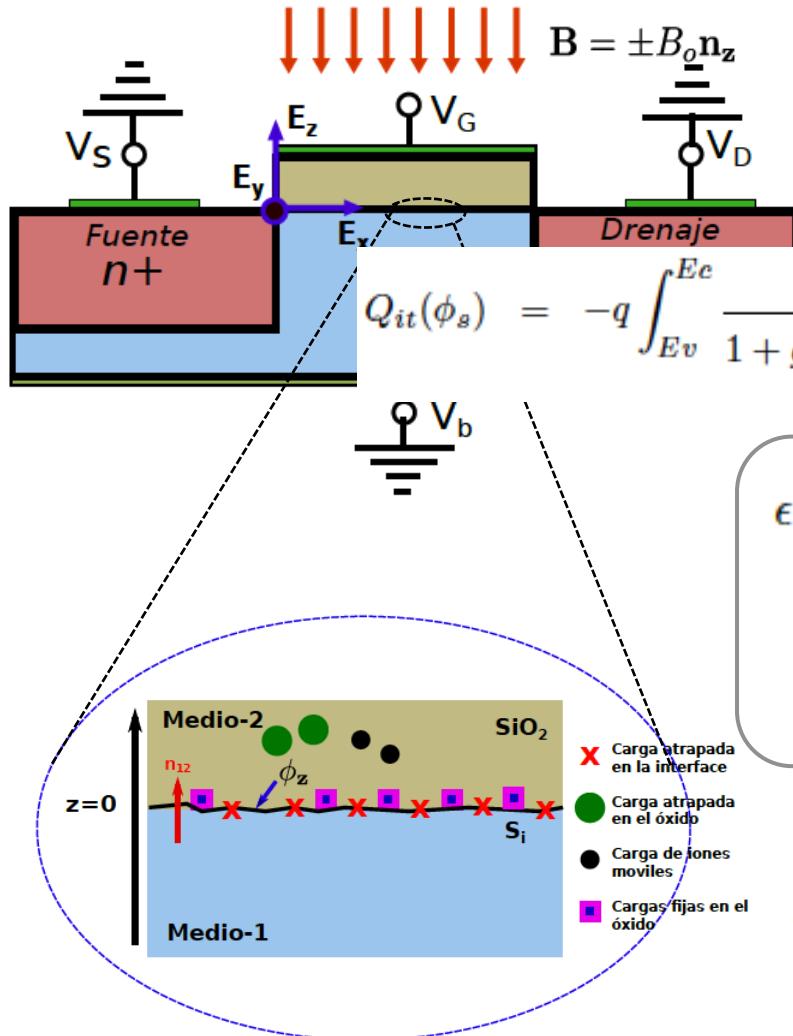
## How the capture/emission is affected by a B field?



Other energy levels (ii) activates?

$$\frac{\tau_c}{\tau_e} \propto \exp\left(\frac{E_T - E_F}{k_B T}\right)$$

# Fundamental research Schrödinger-Poisson with B field and energy traps included.



$$Q_{total} = Q_s(\phi_z) + Q_{it}(\phi_z) + Q_{ox}.$$

$$-\epsilon_{si}\epsilon_0 \frac{d\phi_{si}}{dz}|_{z=0^-} + \epsilon_{ox}\epsilon_0 \frac{d\phi_{ox}}{dz}|_{z=0^+} = Q_s + Q_{it} + Q_{ox},$$

$$Q_{it}(\phi_s) = -q \int_{Ev}^{Ee} \frac{D_{it}^a(E_a)dE_a}{1 + g_a \times \exp\left[\frac{E_a - (q\phi_s - E_F)}{kT}\right]} + q \int_{Ev}^{Ee} \frac{D_{it}^d(E_d)dE_d}{1 + g_d \times \exp\left[\frac{(q\phi_s - E_F) - E_d}{kT}\right]},$$

$$\epsilon(z) \frac{d^2\phi(z)}{dz^2} = q [N_D - n + p - N_A] - \frac{\epsilon(z)}{dz} \frac{d\phi(z)}{dz},$$



$$H^T = \frac{1}{2m} [\mathbf{p} - q\mathbf{A}(\mathbf{r})] + V(\mathbf{r}),$$

$\mathbf{p} = -i\hbar\nabla$ : momentum operator

$\mathbf{A}(\mathbf{r})$ : magnetic field potential vector;  $\mathbf{B} = \nabla \times \mathbf{A}(\mathbf{r})$

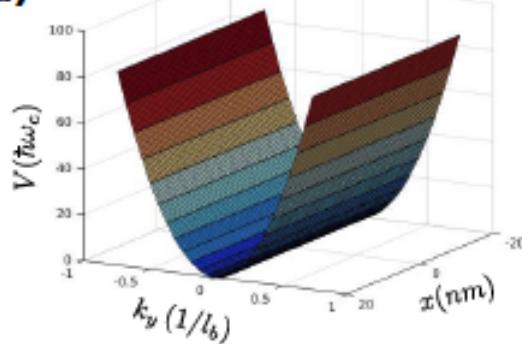
$V(\mathbf{r}) = -q\mathbf{E} \cdot \mathbf{r}$ : potential energy experienced by the  $e^-$

# Numerical calculations with B field included.

$$U(x) = qE_x x$$

$$\hbar\omega_c = 0.01263 \text{ meV}$$

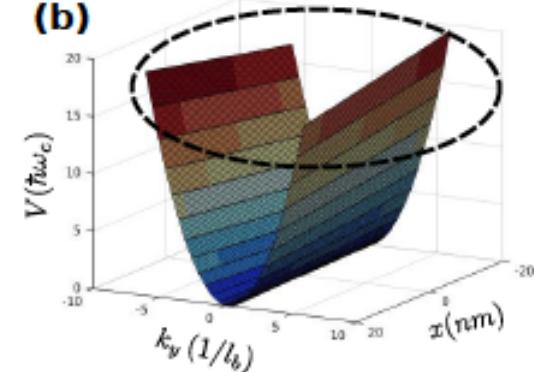
(a)



$$|B_0| = 0.1 \text{ T}$$

$$\hbar\omega_c = 0.01263 \text{ meV}$$

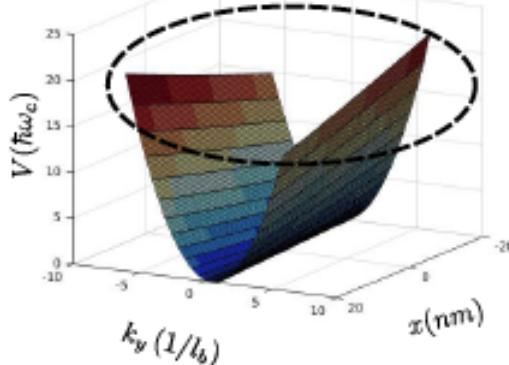
(b)



$$|B_0| = 0.5 \text{ T}$$

$$\hbar\omega_c = 0.0631 \text{ meV}$$

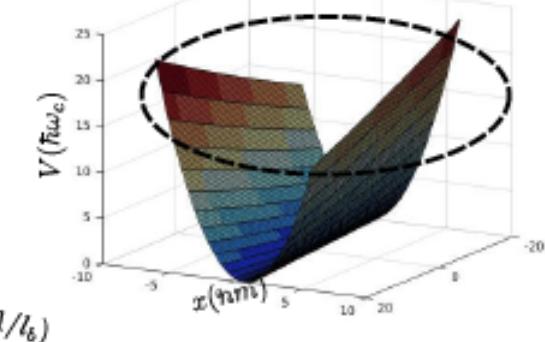
(c)



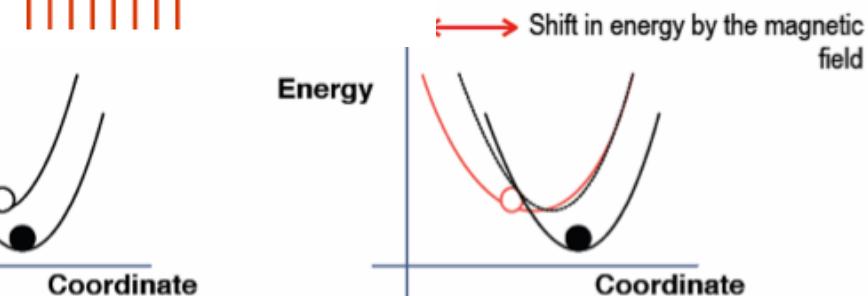
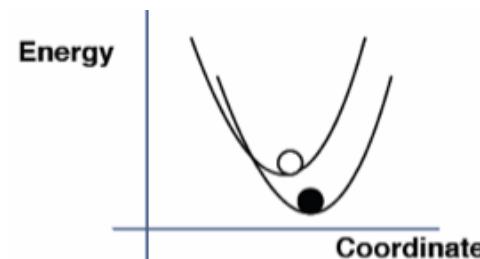
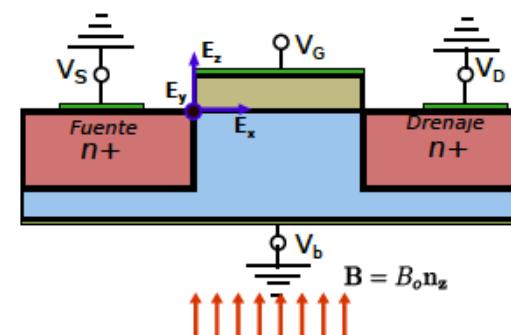
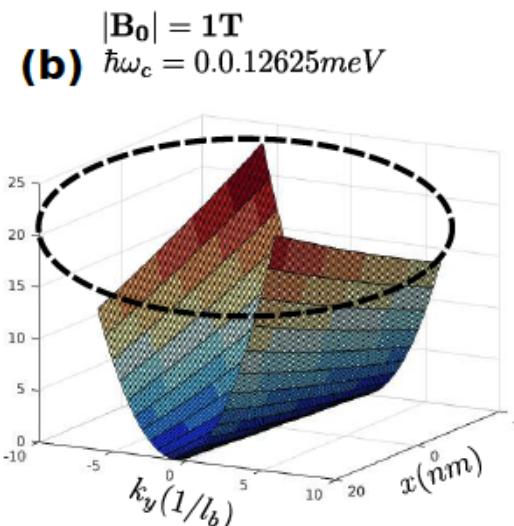
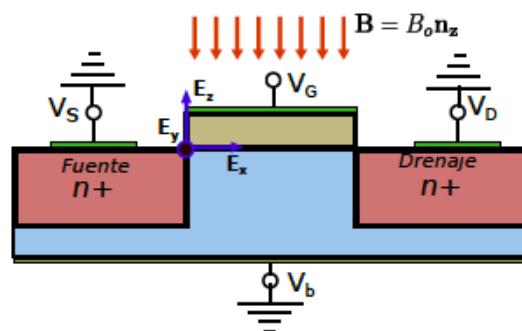
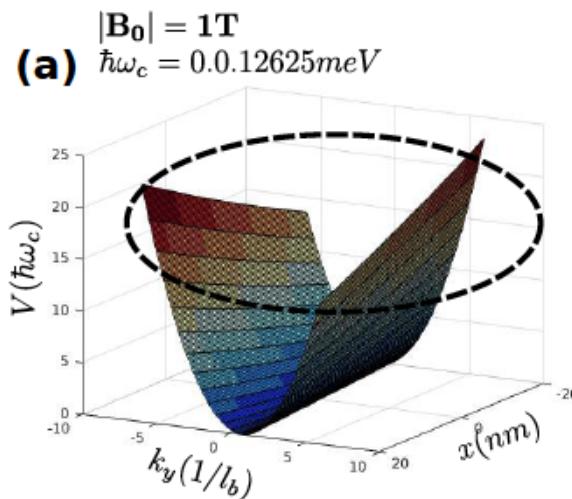
$$|B_0| = 1 \text{ T}$$

$$\hbar\omega_c = 0.012625 \text{ meV}$$

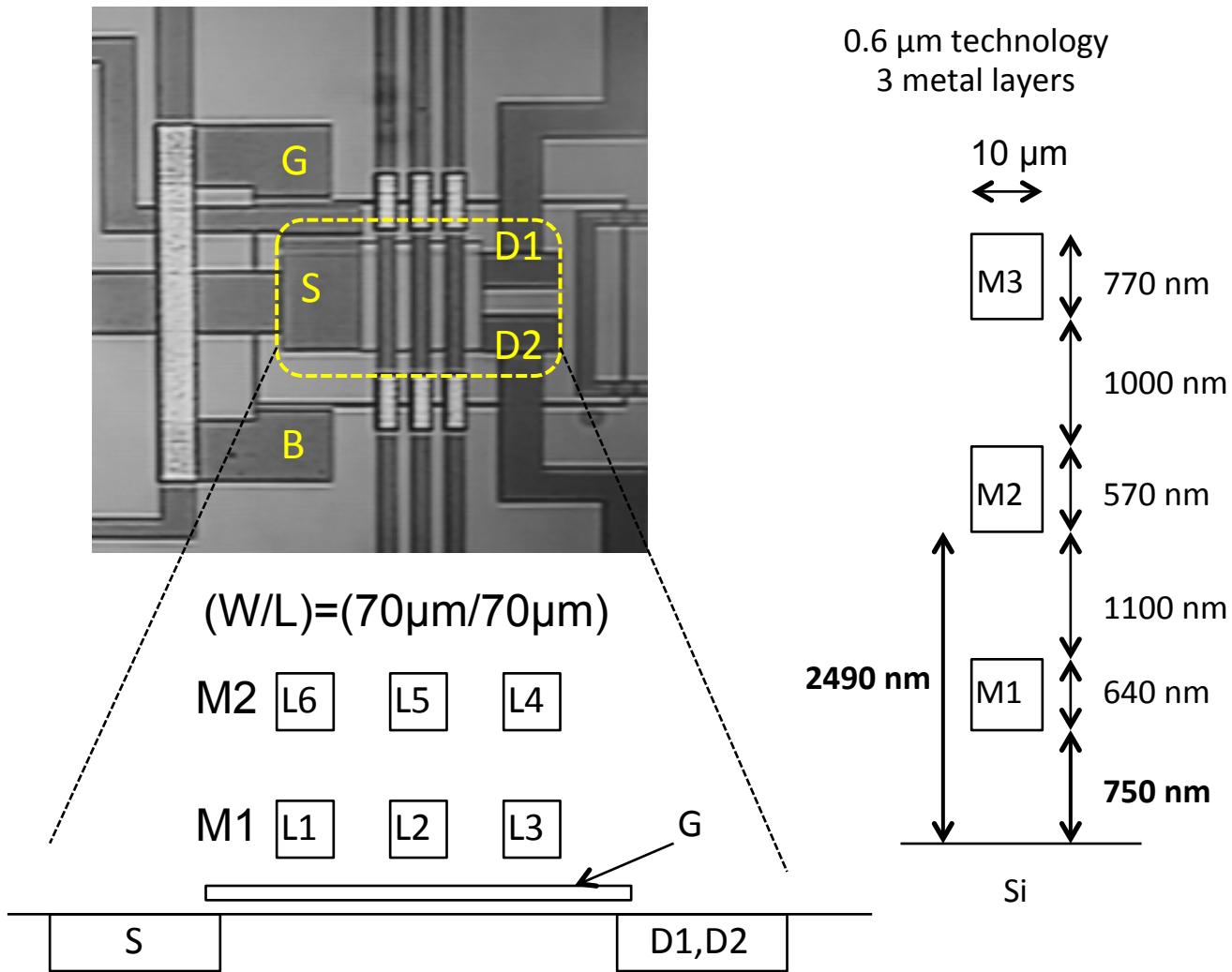
(d)



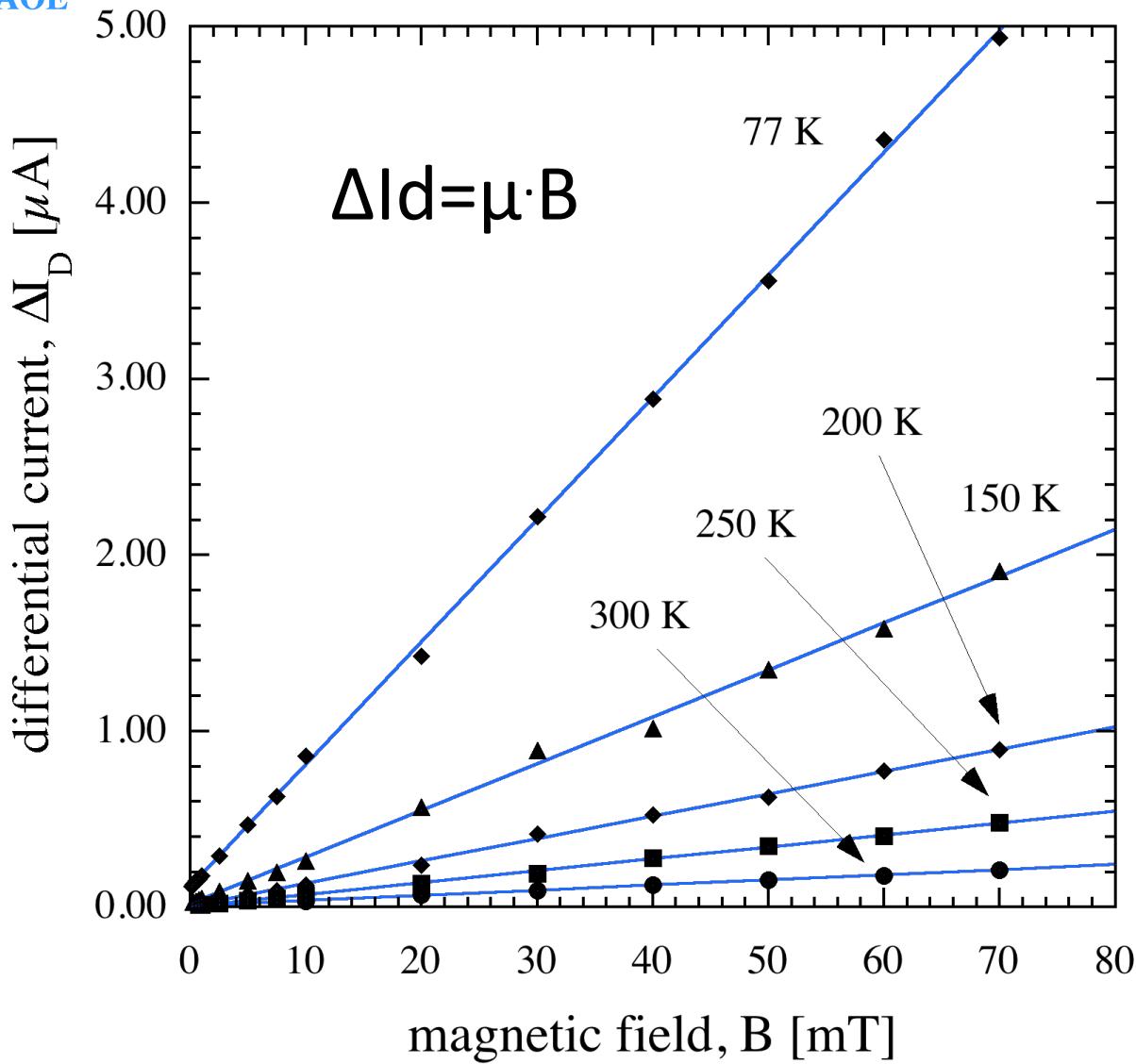
# Fundamental research Schrödinger-Poisson with B field and energy traps included.



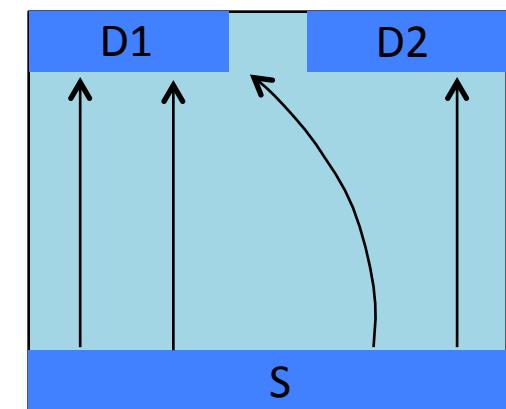
# Integrated magnetic sensor MAGFET



# Magnetic sensor MAGFET behavior as a function of temperature



$$\Delta I_d = |I_{d1} - I_{d2}|$$

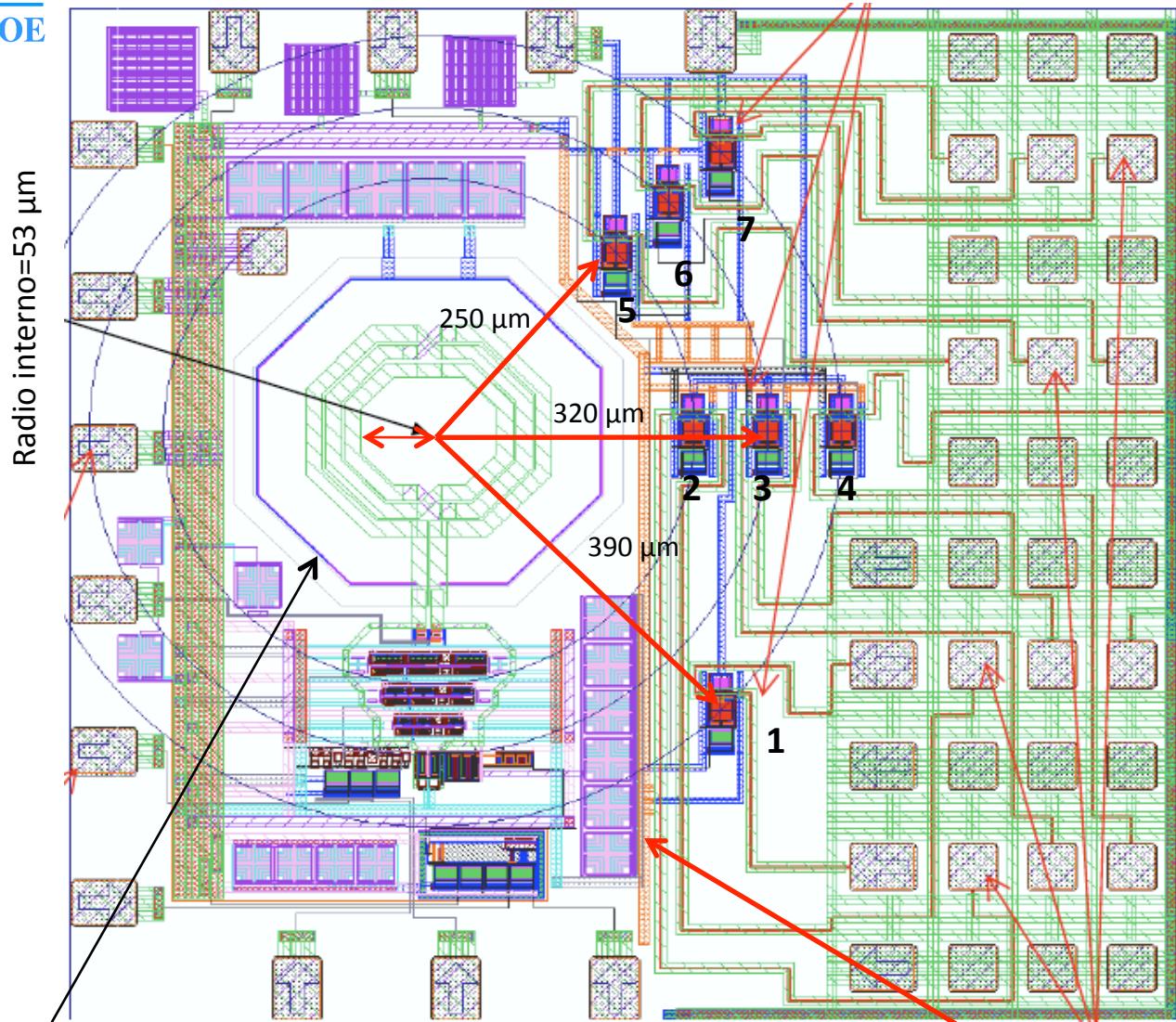


# MAGFET on-chip for frequency monitoring

5.25 GHz VCO 90nm test chip

Sensores magnéticos

Autoinducción de la bobina = 2.0 nH,  
Q=22



Paredes metálicas verticales desde el nivel 9 hasta el nivel 1 de metal

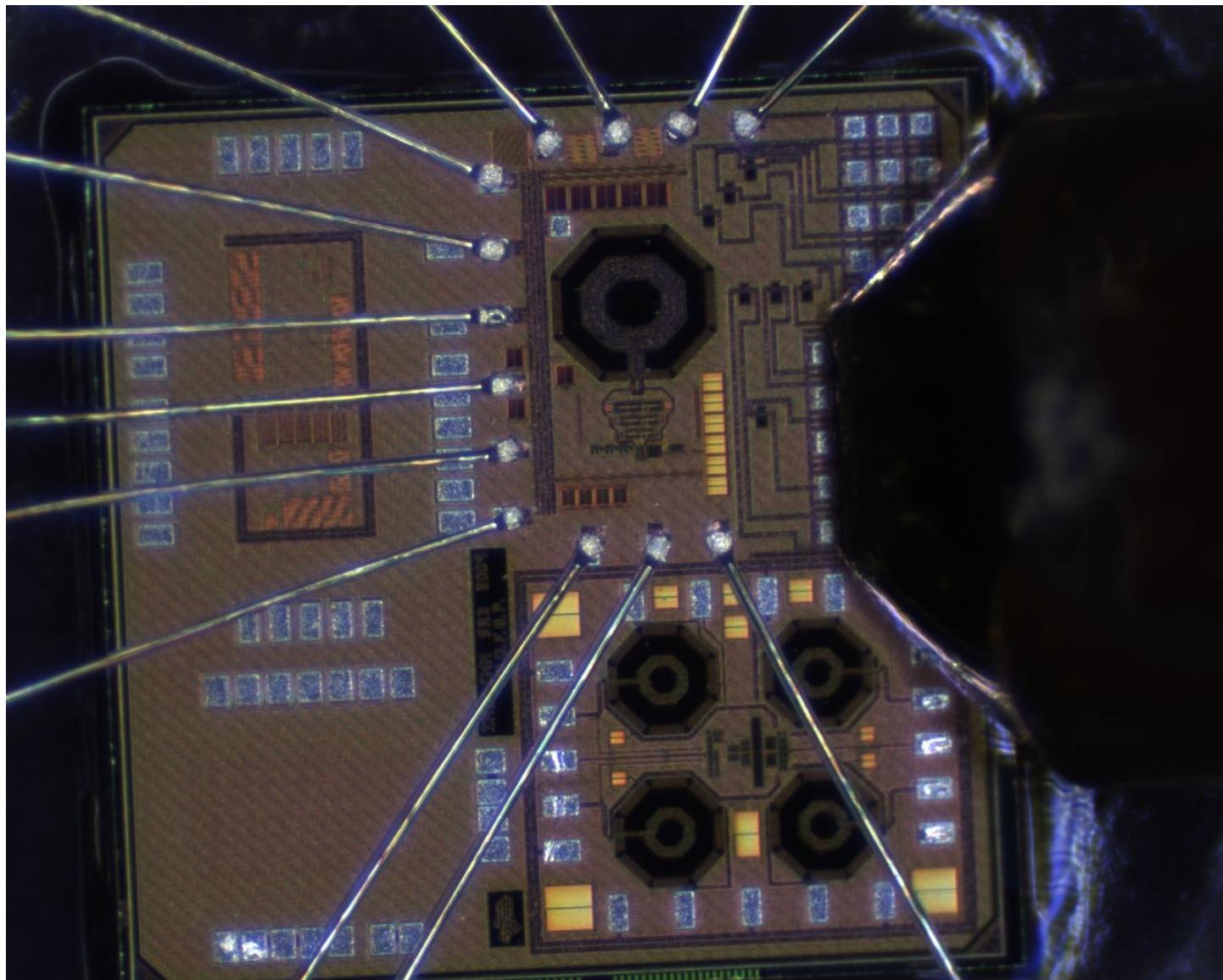
IEEE EDS Distinguished Lecturer

3 vueltas con un ancho de línea de 15 μm en el nivel 9 con un radio interno de 53 μm, lo que da aproximadamente un radio externo de 98 μm.

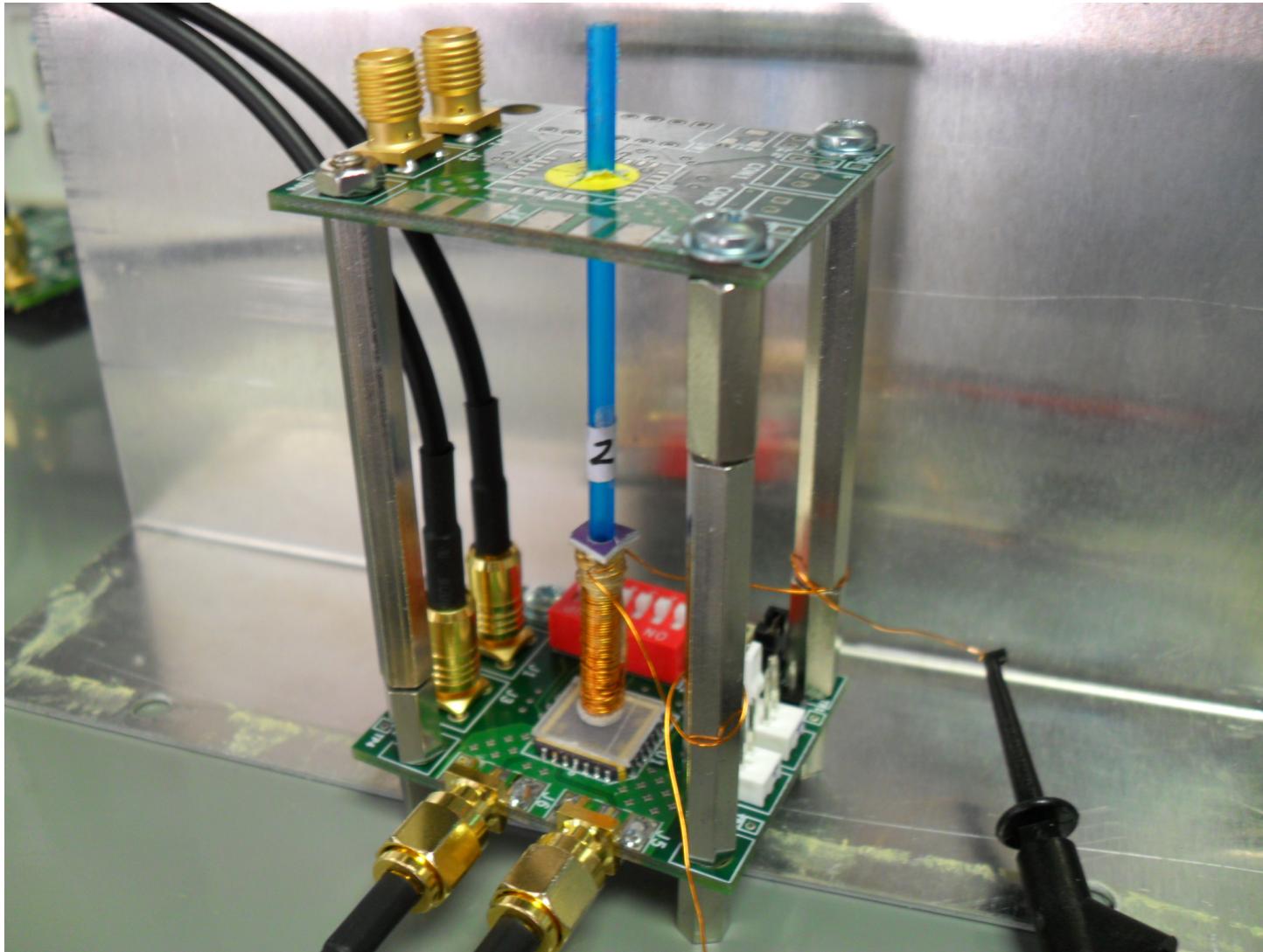
La corriente en la espira depende del estado de polarización del VCO, la nominal es una corriente aproximadamente sinusoidal de unos 12mA pico-pico de amplitud. Para el mínimo consumo del VCO es de unos 4mA pico-pico y para el máximo de unos 20mA pico-pico.

In collaboration with the University of Seville, Spain.

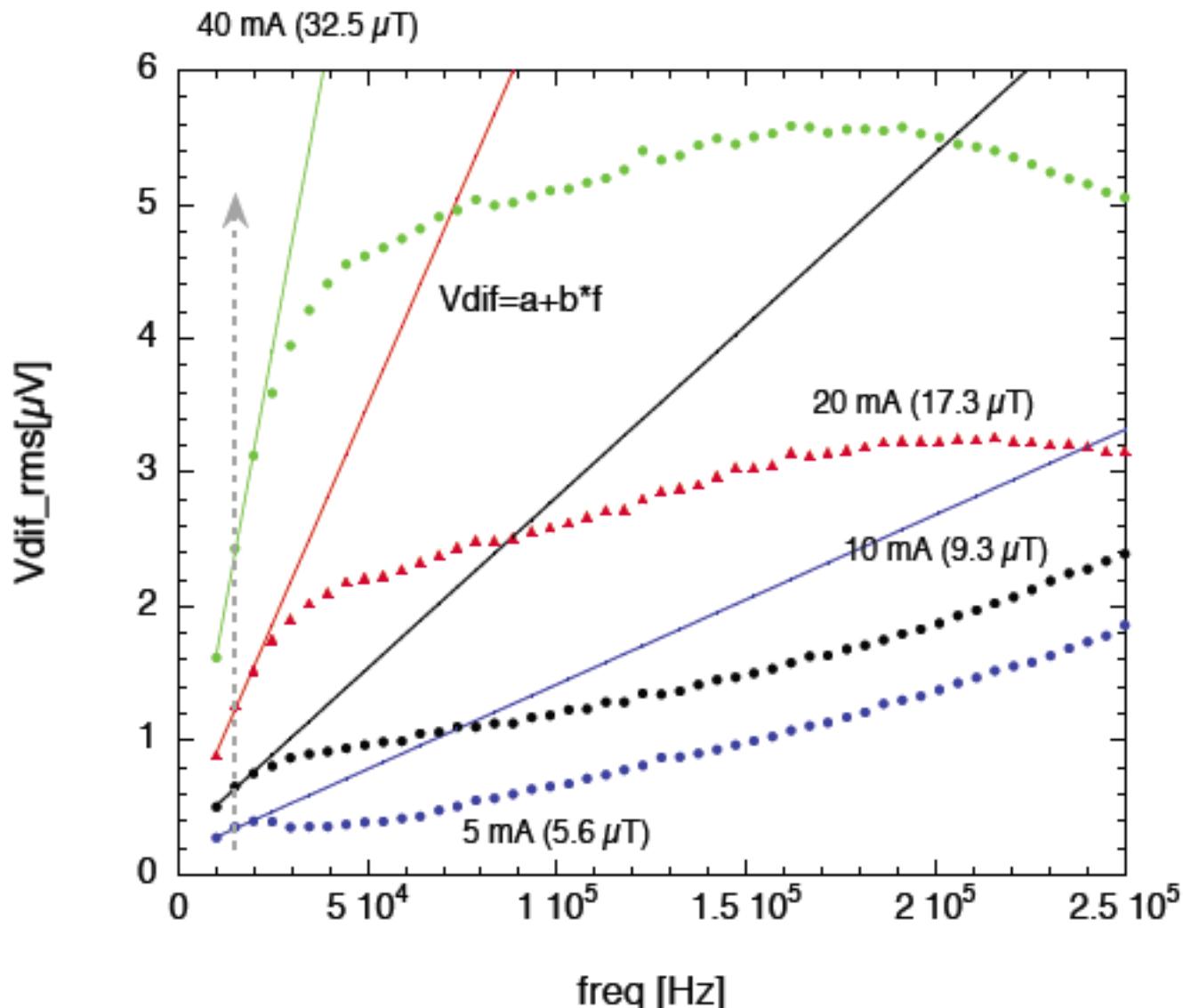
# On-chip electro-magnetic testing at 5.25 GHz



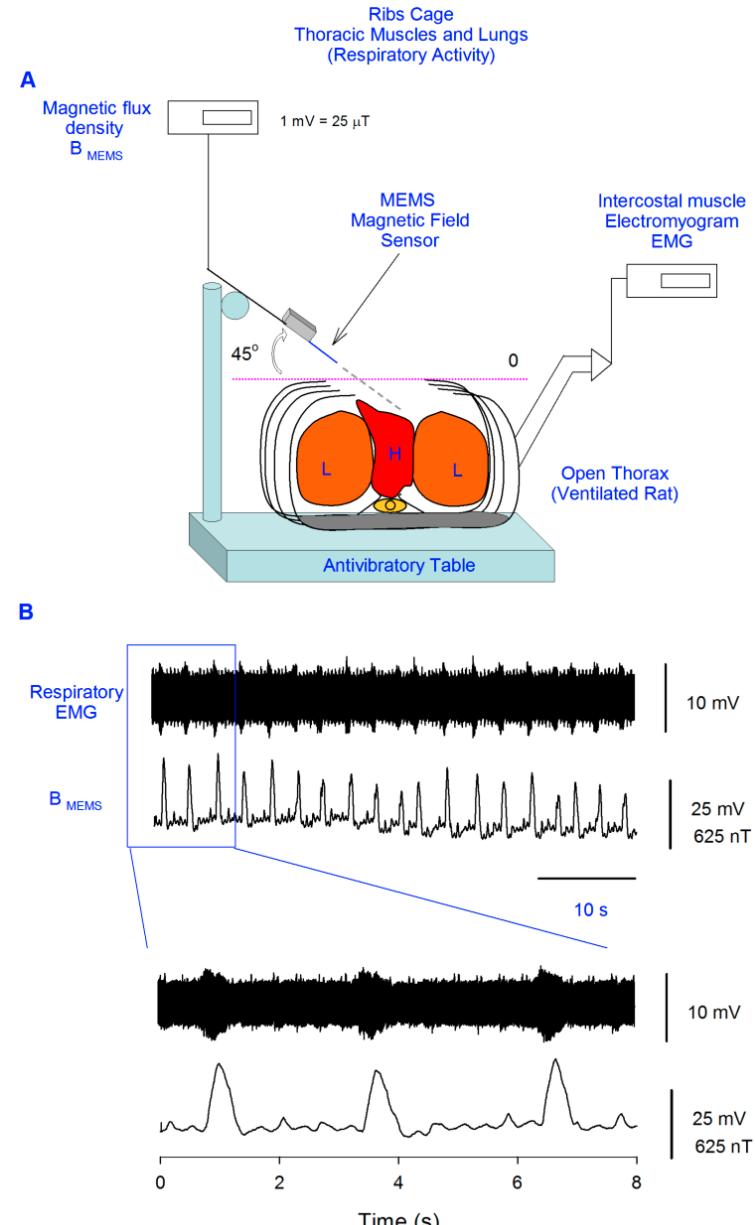
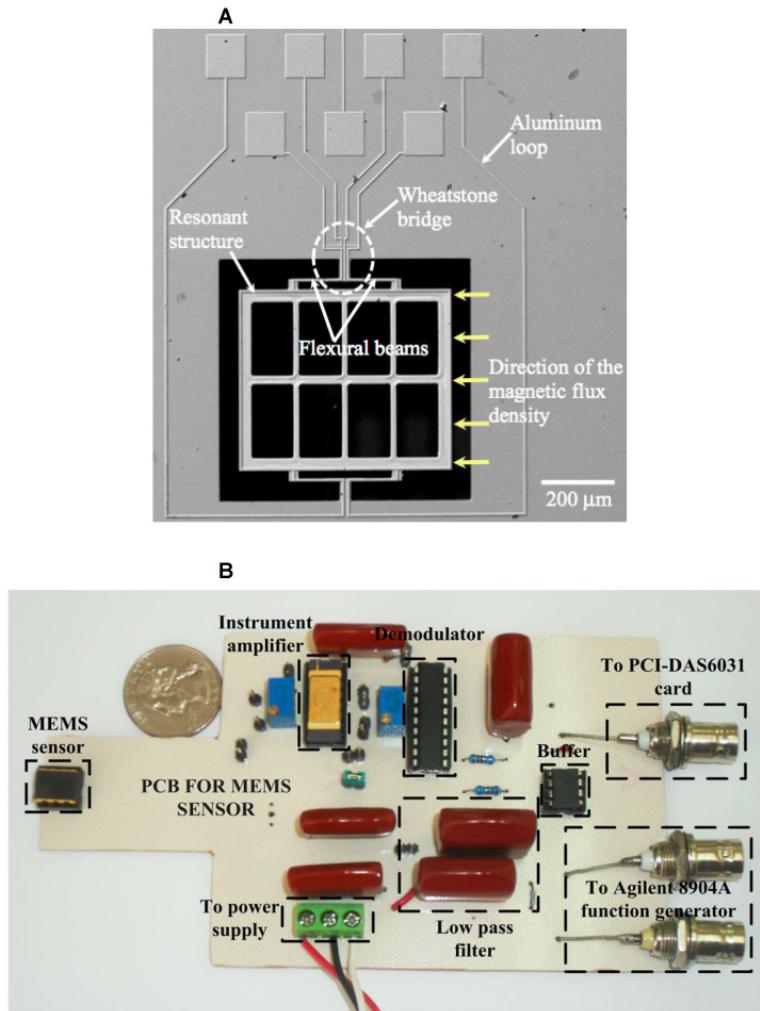
## MAGFET calibration with an external coil



## Experimental results of the on-chip B field sensing



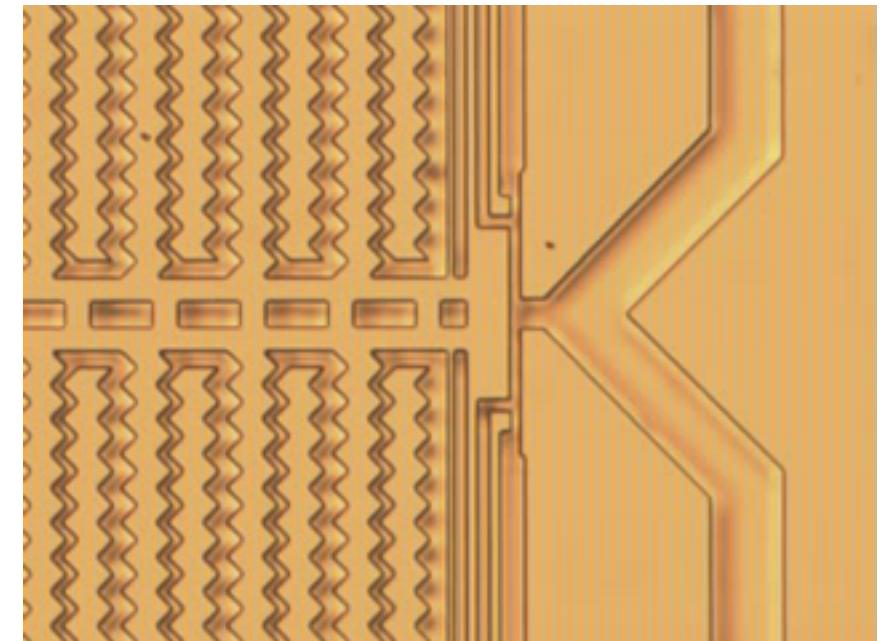
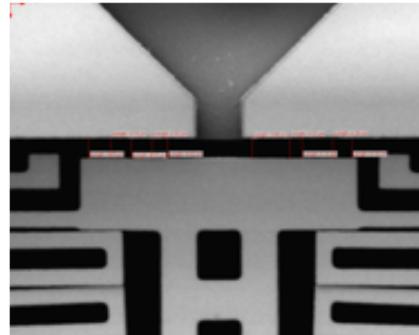
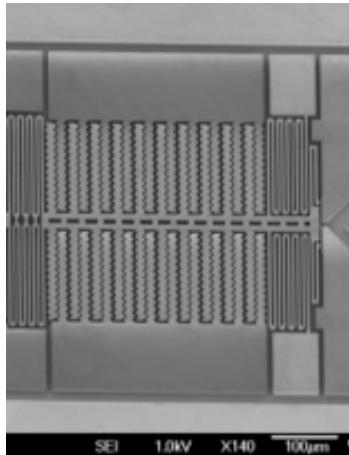
# Cardiac and respiratory magnetograph





# INAOE MEM's-based RF switch design and fabrication

A joint INAOE-Team Technologies, Inc. \$ 10 million USD MEMs-based RF switch.



## RF power amplifier for small cellular base stations

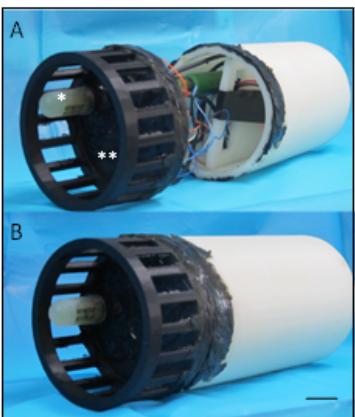
Contacto: Alfonso Torres, [atorres@inaoep.mx](mailto:atorres@inaoep.mx)

INAOE develops the full fabrication process and will do the 10 GHZ characterization, de-embedding and modeling.

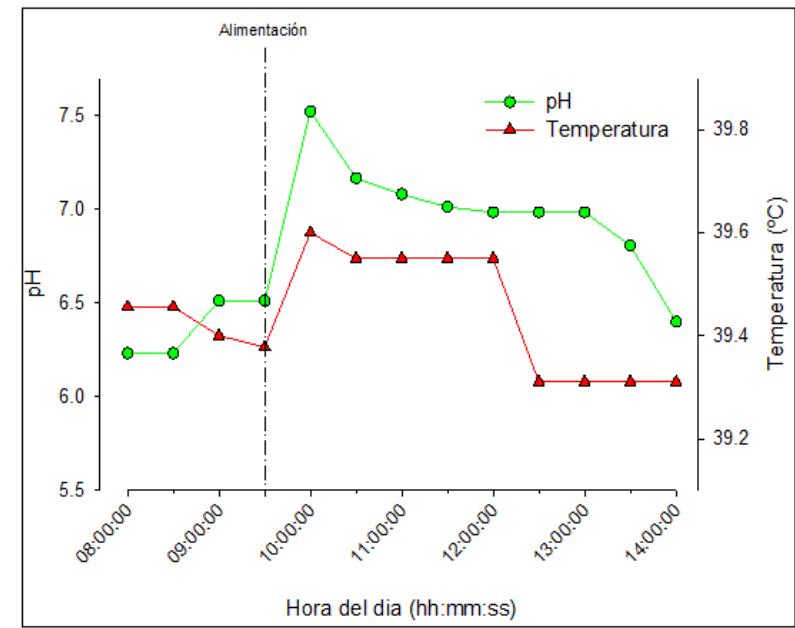
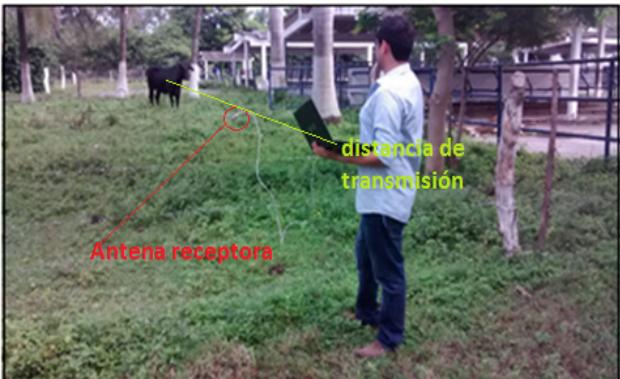
# Hardware and software used for remote bio-sensing



- ISFET-based PH sensor
- Silicon-based temperature sensor
- ZigBee (IEEE 802.15.4), 2.4 GHz



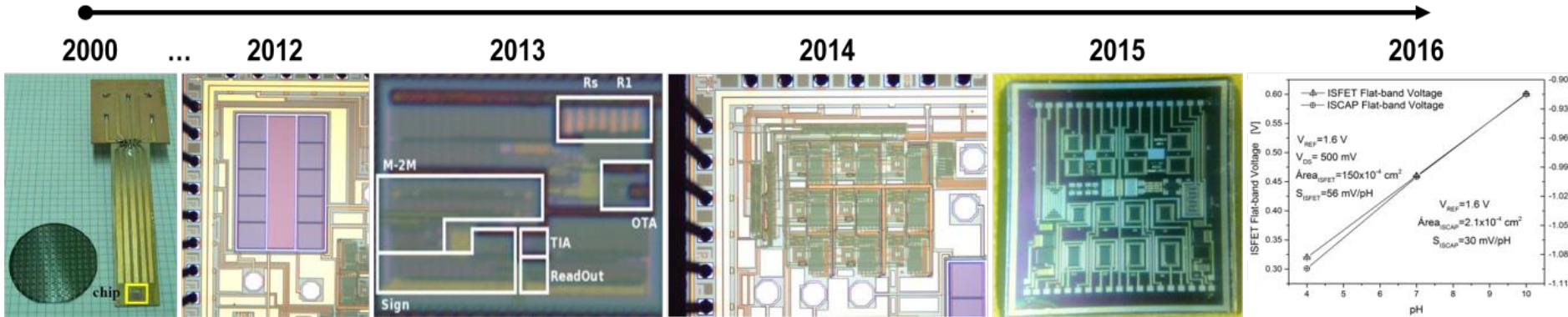
Design, fabrication,  
and test of the in-  
rumen device.  
Instituto Tecnológico  
de Veracruz, México.



CO<sub>2</sub> emissions have been correlated to PH, temperature and associated to a diet model that reduces milk acidity and CO<sub>2</sub> emission.

# Desarrollo y evolución de ISFETs (detectores de iones)

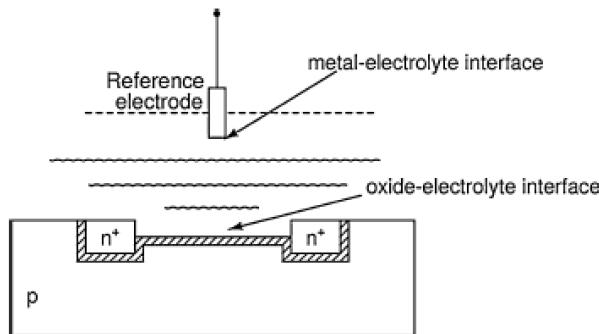
Contacto: Joel Molina, jmolina@inaoep.mx



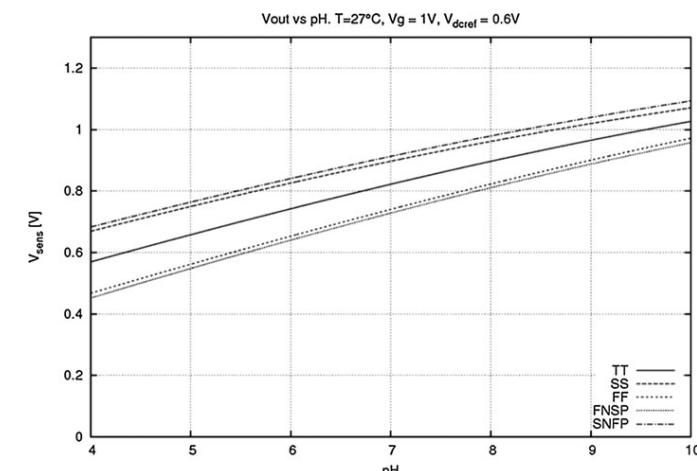
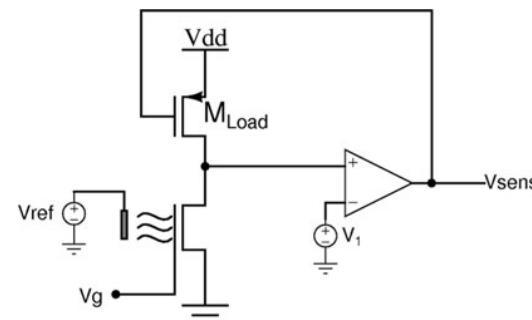
Detección de iones ( $H^+$ ,  $Na^+$ ,  $K^+$ ,  $Ca^+$ , etc) presentes en soluciones biológicas.

- Primera etapa: ISFETs fabricados en INAOE y combinados con MOSIS
- Segunda etapa: ISFETs combinados con pre-amplificadores básicos en INAOE
- Utilizados para medir pH. Fabricados en INAOE con  $Al_2O_3$  ALD, portables y de bajo costo.

Esquemático del IFET



0.18  $\mu m$  OTA+ calibración





# LAEDC

Latin American Electron Devices Conference  
Armenia, Quindio, Colombia  
February 24-27, 2019



Deadline paper submission:  
September 14, 2018

[laedc.cinvestav.edu](http://laedc.cinvestav.edu)

LAEDC is a conference cosponsored by the IEEE Electron Device society. Its main goal is to bring together specialists from all Electron Device related fields. It will take place in Armenia, Colombia, and it will be co-located with LASCAS.

Proceedings will be published by IEEE and will be available on IEEE Xplore.

Social Activities: Besides the technical program, a welcome reception and a gala dinner are planned. Visitors will have the opportunity to visit several tourist attractions.

## Topics of Interest:

### All electron based devices

Semiconductor-, MEMS- and Nano-technologies  
Packaging, 3D integration,  
Sensors and actuators  
Display technology  
Modeling and simulation  
Reliability and yield  
Device characterization  
Energy harvesting

Biomedical Devices  
Circuit-device interaction  
Novel materials and process modules  
Technology roadmaps  
Electron device engineering education  
Electron device outreach  
Optoelectronics, photovoltaic and photonic devices and systems

Armenia City is the capital of the department of Quindio. It is located in the Colombian region known as the coffee triangle. Since 2011, this region is recognized by the UNESCO as a world cultural heritage due to its exceptional landscapes that are the mixture of natural beauty and cultural traditions around the coffee growing. Different theme parks related to cultural and agricultural traditions are also located in the department of Quindio, which turns out the LAEDC an opportunity not only for academic exchange but also for knowing and enjoying the traditions around the coffee growing.



## Program chairs:

Arturo Escobosa ([escobosa@cinvestav.mx](mailto:escobosa@cinvestav.mx)), Lluis Marsal ([lluis.marsal@urv.cat](mailto:lluis.marsal@urv.cat))

IEEE EDS Distinguished Lecturer

SBMICRO2018, Brazil, August 28, 2018



# Muito Obrigado!

